FUJITSU SEMICONDUCTOR
DATA SHEET

8-bit Proprietary Microcontroller

CMOS

F²MC-8L MB89620 Series

**MB89623/T623/V623/625/P625/W625/T625/V625/626/627/P627/W627
MB89PV620**

■ DESCRIPTION

The MB89620 series has been developed as a general-purpose version of the F²MC*-8L family consisting of proprietary 8-bit, single-chip microcontrollers.

In addition to the F²MC-8L CPU core which can operate at low voltage but at high speed, the microcontrollers contain a variety of peripheral functions such as timers, serial interfaces, an A/D converter, and an external interrupt.

The MB89620 series is applicable to a wide range of applications from welfare products to industrial equipment, including portable devices.

*: F²MC stands for FUJITSU Flexible Microcontroller.

■ FEATURES

- Various package options
  Three types of QFP packages (1-mm, 0.65-mm, or 0.5-mm lead pitch)
  SDIP packages
- High-speed processing at low voltage
  Minimum execution time: 0.4 µs/3.5 V, 0.8 µs/2.7 V
- F²MC-8L family CPU core

  Instruction set optimized for controllers $\begin{cases} \text{Multiplication and division instructions} \\ \text{16-bit arithmetic operations} \\ \text{Test and branch instructions} \\ \text{Bit manipulation instructions, etc.} \end{cases}$

- Four types of timers
  8-bit PWM timer (also usable as a reload timer)
  8-bit pulse width count timer (Continuous measurement capable, applicable to remote control, etc.)
  16-bit timer/counter
  20-bit time-base timer
- Two serial interfaces
  Switchable transfer direction allows communication with various equipment.
- 8-bit A/D converter
  Sense mode function enabling comparison at 5 µs
 Activation by an external input capable

MB89620 Series

(Continued)
- External interrupt: 4 channels
  Four channels are independent and capable of wake-up from low-power consumption modes (with an edge detection function).
- Low-power consumption modes
  Stop mode (Oscillation stops to minimize the current cunsumption.)
  Sleep mode (The CPU stops to reduce the current consumption to approx. 1/3 of normal.)
- Bus interface functions
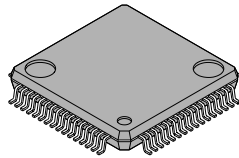 Including hold and ready functions
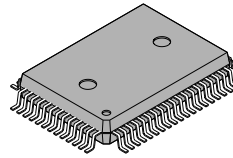
■ PACKAGE

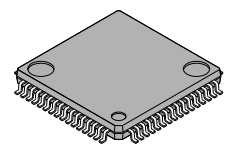64-pin Plastic SH-DIP
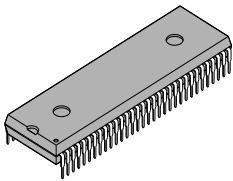
(DIP-64P-M01)

64-pin Plastic SQFP

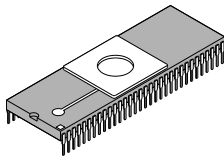(FPT-64P-M03)

64-pin Plastic QFP

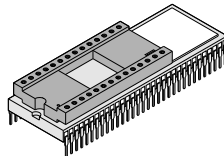(FPT-64P-M06)

64-pin Plastic QFP
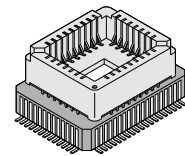
(FPT-64P-M09)

64-pin Ceramic SH-DIP

(DIP-64C-A06)

64-pin Ceramic MDIP

(MDP-64C-P02)

64-pin Ceramic MQFP

(MQP-64C-P01)

■ PRODUCT LINEUP

Part number / Parameter	MB89623	MB89625	MB89626	MB89627	MB89P625 MB89W625	MB89P627 MB89W627	MB89T623 MB89V623	MB89T625 MB89V625	MB89PV620
Classification	Mass production products (mask ROM products)				One-time PROM products/EPROM products		External ROM products/For evaluation and development		Piggyback/ evaluation product for evaluation and development
ROM size	8 K × 8 bits (internal mask ROM)	16 K × 8 bits (internal mask ROM)	24 K × 8 bits (internal mask ROM)	32 K × 8 bits (internal mask ROM)	16 K × 8 bits (internal PROM, programming with general-purpose EPROM programmer)	32 K × 8 bits (internal PROM, programming with general-purpose EPROM programmer)	External ROM		32 K × 8 bits (external ROM)
RAM size	256 × 8 bits	512 × 8 bits	768 × 8 bits	1 K × 8 bits	512 × 8 bits	1 K × 8 bits	256 × 8 bits	512 × 8 bits	1 K × 8 bits
CPU functions	Number of instructions: 136 Instruction bit length: 8 bits Instruction length: 1 to 3 bytes Data bit length: 1, 8, 16 bits Minimum execution time: 0.4 µs /10 MHz Interrupt processing time: 3.6 µs/10 MHz								
Ports	Input ports: 5 (4 ports also serve as peripherals.) Output ports (N-ch open-drain): 8 (All also serve as peripherals.) I/O ports (N-ch open-drain) 8 (4 ports also serve as peripherals.) Output ports (CMOS): 8 (All also serve as bus control pins.) I/O ports (CMOS): 24 (All also serve as bus pins or peripherals.) Total: 53								
8-bit PWM timer	8-bit reload timer operation (toggled output capable, operating clock cycle: 0.4 µs to 3.3 ms) 8-bit resolution PWM operation (conversion cycle: 102 µs to 839 ms)								
8-bit pulse width count timer	8-bit timer operation (overflow output capable, operating clock cycle: 0.4 to 12.8 µs) 8-bit reload timer operation (toggled output capable, operating clock cycle: 0.4 to 12.8 µs) 8-bit pulse width measurement operation (Continuous measurement "H" pulse width/"L" pulse width/from ↑ to ↑/from ↓ to ↓ capable)								
16-bit timer/ counter	16-bit timer operation (operating clock cycle: 0.4 µs) 16-bit event counter operation (Rising/falling/both edges selectability)								
8-bit serial I/O 1, 8-bit serial I/O 2	8 bits LSB first/MSB first selectability One clock selectable from four transfer clocks (one external shift clock, three internal shift clocks: 0.8 µs, 3.2 µs, 12.8 µs)								
8-bit A/D converter	8-bit resolution × 8 channels A/D conversion mode (conversion time: 18 µs) Sense mode (conversion time: 5 µs) Continuous activation by an external activation or an internal timer capable Reference voltage input								

(Continued)

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MB89620 Series

(Continued)

Part number / Parameter	MB89623	MB89625	MB89626	MB89627	MB89P625 MB89W625	MB89P627 MB89W627	MB89T623 MB89V623	MB89T625 MB89V625	MB89PV620
External interrupt	4 independent channels (edge selection, interrupt vector, source flag) Rising edge/falling edge selectability Used also for wake-up from stop/sleep mode. (Edge detection is also permitted in stop mode.)								
Standby modes	Sleep mode, stop mode								
Process	CMOS								
Operating voltage*	2.2 V to 6.0 V				2.7 V to 6.0 V				
EPROM for use									MBM27C256A-20

*: Varies with conditions such as the operating frequency. (See section "■ Electrical Characteristics.")

■ PACKAGE AND CORRESPONDING PRODUCTS

Package	MB89623 MB89625 MB89T623 MB89T625	MB89626 MB89627 MB89P625	MB89P627	MB89W625 MB89W627	MB89V623 MB89V625	MB89PV620
DIP-64P-M01	○	○	○	×	○	×
DIP-64C-A06	×	×	×	○	×	×
FPT-64P-M03	○	×*	×*	×*	×*	×*
FPT-64P-M06	○	○	○	×	×	×
FPT-64P-M09	○	○	×*	×*	×*	×*
MDP-64C-P02	×	×	×	×	×	○
MQP-64C-P01	×	×	×	×	×	○

○: Available   ×: Not available

*: Lead pitch converter sockets (manufacturer: Sun Hayato Co., Ltd.) are available.
   64SD-64QF2-8L: For conversion from DIP-64P-M01 or DIP-64C-A06 to FPT-64P-M03
   64SD-64SQF-8L: For conversion from DIP-64P-M01 or DIP-64C-A06 to FPT-64P-M09
   Inquiry: Sun Hayato Co., Ltd. : TEL 81-3-3802-5760

Note: For more information about each package, see section "■ Package Dimensions."

■ DIFFERENCES AMONG PRODUCTS

1. Memory Size

Before evaluating using the piggyback product, verify its differences from the product that will actually be used. Take particular care on the following points:

- On the MB89623, MB89T623, and MB89V623, the upper half of each register bank cannot be used.

- On the MB89P627, the program area starts from address 8006_H but on the MB89PV620 and MB89627 starts from 8000_H.

  (On the MB89P627, addresses 8000_H to 8006_H comprise the option setting area, option settings can be read by reading these addresses. On the MB89PV620 and MB89627, addresses 8000_H to 8006_H could also be used as a program ROM. However, do not use these addresses in order to maintain compatibility of the MB89P627A.)

- The stack area, etc., is set at the upper limit of the RAM.

- The external area is used.

2. Current Consumption

- In the case of the MB89PV620, add the current consumed by the EPROM which is connected to the top socket.

- When operated at low speed, the product with an OTPROM (one-time PROM) or an EPROM will consume more current than the product with a mask ROM.

  However, the current consumption in sleep/stop modes is the same. (For more information, see section "■ Electrical Characteristics".)

3. Mask Options

Functions that can be selected as options and how to designate these options vary by the product.

Before using options check section "■ Mask Options."

Take particular care on the following points:

- A pull-up resistor cannot be set for P40 to P47 on the MB89P625, MB89W625, MB89P627, and MB89W627.

- A pull-up resistor is not selectable for P50 to P57 when the A/D converter is used.

- Options are fixed on the MB89PV620.

■ CORRESPONDENCE BETWEEN THE MB89620 AND MB89620R SERIES

- The MB89620R series is the reduction version of the MB89620 series.
  For their differences, refer to the MB89620R series data sheet.

- The MB89620 and MB89620R series consist of the following products:

MB89620 series	MB89623	MB89625	MB89626	MB89P625	MB89P627	MB89W625	MB89W627	MB89PV620
MB89620R series	MB89623R	MB89625R	MB89626R	—	—	—	—	—

MB89620 Series

■ PIN ASSIGNMENT

(Top view)

P36/WTO	1	64 Vcc
P37/PTO	2	63 P35/PWC
P40	3	62 P34/EC
P41	4	61 P33/SI1
P42	5	60 P32/SO1
P43	6	59 P31/SCK1
P44/BZ	7	58 P30/ADST
P45/SCK2	8	57 Vss
P46/SO2	9	56 P00/AD0
P47/SI2	10	55 P01/AD1
P50/AN0	11	54 P02/AD2
P51/AN1	12	53 P03/AD3
P52/AN2	13	52 P04/AD4
P53/AN3	14	51 P05/AD5
P54/AN4	15	50 P06/AD6
P55/AN5	16	49 P07/AD7
P56/AN6	17	48 P10/A08
P57/AN7	18	47 P11/A09
AVcc	19	46 P12/A10
AVR	20	45 P13/A11
AVss	21	44 P14/A12
P60/INT0	22	43 P15/A13
P61/INT1	23	42 P16/A14
P62/INT2	24	41 P17/A15
P63/INT3	25	40 P20/BUFC
P64	26	39 P21/HAK
RST	27	38 P22/HRQ
MOD0	28	37 P23/RDY
MOD1	29	36 P24/CLK
X0	30	35 P25/WR
X1	31	34 P26/RD
Vss	32	33 P27/ALE

Pins inside the dashed line (for the MB89PV620 only):

VPP	65	92	Vcc
A12	66	91	A14
A7	67	90	A13
A6	68	89	A8
A5	69	88	A9
A4	70	87	A11
A3	71	86	OE
A2	72	85	A10
A1	73	84	CE
A0	74	83	O8
O1	75	82	O7
O2	76	81	O6
O3	77	80	O5
Vss	78	79	O4

Each pin inside the dashed line is for the MB89PV620 only.

(DIP-64P-M01)
(DIP-64C-A06)
(MDP-64C-P02)

(Top view)

Top pins (64–49):
P45/SCK2, P44/BZ, P43, P42, P41, P40, P37/PTO, P36/WTO, Vcc, P35/PWC, P34/EC, P33/SI1, P32/SO1, P31/SCK1, P30/ADST, Vss

P46/SO2	1	48 P00/AD0
P47/SI2	2	47 P01/AD1
P50/AN0	3	46 P02/AD2
P51/AN1	4	45 P03/AD3
P52/AN2	5	44 P04/AD4
P53/AN3	6	43 P05/AD5
P54/AN4	7	42 P06/AD6
P55/AN5	8	41 P07/AD7
P56/AN6	9	40 P10/A08
P57/AN7	10	39 P11/A09
AVcc	11	38 P12/A10
AVR	12	37 P13/A11
AVss	13	36 P14/A12
P60/INT0	14	35 P15/A13
P61/INT1	15	34 P16/A14
P62/INT2	16	33 P17/A15

Bottom pins (17–32):
P63/INT3, P64, RST, MOD0, MOD1, X0, X1, Vss, P27/ALE, P26/RD, P25/WR, P24/CLK, P23/RDY, P22/HRQ, P21/HAK, P20/BUFC

(FPT-64P-M03)
(FPT-64P-M09)

(Top view)

(FPT-64P-M06)
(MQP-64C-P01)

- •**Pin assignment on package top (MB89PV620 only)**

Pin no.	Pin name	Pin no.	Pin name	Pin no.	Pin name	Pin no.	Pin name
65	N.C.	73	A2	81	N.C.	89	$\overline{OE}$
66	V_{PP}	74	A1	82	O4	90	N.C.
67	A12	75	A0	83	O5	91	A11
68	A7	76	N.C.	84	O6	92	A9
69	A6	77	O1	85	O7	93	A8
70	A5	78	O2	86	O8	94	A13
71	A4	79	O3	87	$\overline{CE}$	95	A14
72	A3	80	V_{SS}	88	A10	96	V_{CC}

N.C.: Internally connected. Do not use.

MB89620 Series

■ PIN DESCRIPTION

SH-DIP[*1] MDIP[*2]	QFP1[*3] MQFP[*4]	SQFP[*5] QFP2[*6]	Pin name	Circuit type	Function
30	23	22	X0	A	Crystal oscillator pins
31	24	23	X1		
28	21	20	MOD0	B	Operating mode selection pins Connect directly to V_{CC} or V_{SS}.
29	22	21	MOD1		
27	20	19	$\overline{RST}$	C	Reset I/O pin This pin is an N-ch open-drain output type with a pull-up resistor, and a hysteresis input type. "L" is output from this pin by an internal reset source. The internal circuit is initialized by the input of "L".
56 to 49	49 to 42	48 to 41	P00/AD0 to P07/AD7	D	General-purpose I/O ports When an external bus is used, these ports function as multiplex pins of lower address output and data I/O.
48 to 41	41 to 34	40 to 33	P10/A08 to P17/A15	D	General-purpose I/O ports When an external bus is used, these ports function as upper address output.
40	33	32	P20/BUFC	F	General-purpose output-only port When an external bus is used, this port can also be used as a buffer control output by setting the BCTR.
39	32	31	P21/$\overline{HAK}$	F	General-purpose output-only port When an external bus is used, this port can also be used as a hold acknowledge output by setting the BCTR.
38	31	30	P22/HRQ	D	General-purpose output-only port When an external bus is used, this port can also be used as a hold request input by setting the BCTR.
37	30	29	P23/RDY	D	General-purpose output-only port When an external bus is used, this port functions as a ready input.
36	29	28	P24/CLK	F	General-purpose output-only port When an external bus is used, this port functions as a clock output.
35	28	27	P25/$\overline{WR}$	F	General-purpose output-only port When an external bus is used, this port functions as a write signal output.
34	27	26	P26/$\overline{RD}$	F	General-purpose output-only port When an external bus is used, this port functions as a read signal output.
33	26	25	P27/ALE	F	General-purpose output-only port When an external bus is used, this port functions as an address latch signal output.

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*1: DIP-64P-M01, DIP-64C-A06   *2: MDP-64C-P02   *3: FPT-64P-M06
*4: MQP-64C-P01   *5: FPT-64P-M03   *6: FPT-64P-M09

(Continued)

Pin no.			Pin name	Circuit type	Function
SH-DIP[*1] MDIP[*2]	QFP1[*3] MQFP[*4]	SQFP[*5] QFP2[*6]			
58	51	50	P30/ADST	E	General-purpose I/O port Also serves as an A/D converter external activation. This port is a hysteresis input type.
59	52	51	P31/SCK1	E	General-purpose I/O port Also serves as the clock I/O for the 8-bit serial I/O 1. This port is a hysteresis input type.
60	53	52	P32/SO1	E	General-purpose I/O port Also serves as the data output for the 8-bit serial I/O 1. This port is a hysteresis input type.
61	54	53	P33/SI1	E	General-purpose I/O port Also serves as the data input for the 8-bit serial I/O 1. This port is a hysteresis input type.
62	55	54	P34/EC	E	General-purpose I/O port Also serves as the external clock input for the 16-bit timer/counter. This port is a hysteresis input type.
63	56	55	P35/PWC	E	General-purpose I/O port Also serves as the measured pulse input for the 8-bit pulse width count timer. This port is a hysteresis input type.
1	58	57	P36/WTO	E	General-purpose I/O port Also serves as the toggle output for the 8-bit pulse width count timer. This port is a hysteresis input type.
2	59	58	P37/PTO	E	General-purpose I/O port Also serves as the toggle output for the 8-bit PWM timer. This port is a hysteresis input type.
3 to 6	60 to 63	59 to 62	P40 to P43	G	N-ch open-drain I/O ports These ports are a hysteresis input type.
7	64	63	P40/BZ	G	N-ch open-drain I/O port Also serves as a buzzer output. This port is a hysteresis input type.
8	1	64	P45/SCK2	G	N-ch open-drain I/O port Also serves as the clock I/O for the 8-bit serial I/O 2. This port is a hysteresis input type.
9	2	1	P46/SO2	G	N-ch open-drain I/O port Also serves as the data output for the 8-bit serial I/O 2. This port is a hysteresis input type.
10	3	2	P47/SI2	G	N-ch open-drain I/O port Also serves as the data input for the 8-bit serial I/O 2. This port is a hysteresis input type.

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*1: DIP-64P-M01, DIP-64C-A06   *2: MDP-64C-P02   *3: FPT-64P-M06
*4: MQP-64C-P01   *5: FPT-64P-M03   *6: FPT-64P-M09

MB89620 Series

(Continued)

Pin no.			Pin name	Circuit type	Function
SH-DIP[*1] MDIP[*2]	QFP1[*3] MQFP[*4]	SQFP[*5] QFP2[*6]			
11 to 18	4 to 11	3 to 10	P50/AN0 to P57/AN7	H	N-ch open-drain output-only ports Also serve as the analog input for the A/D converter.
22 to 25	15 to 18	14 to 17	P60/INT0 to P63/INT3	I	General-purpose input-only ports Also serve as an external interrupt input. These ports are a hysteresis input type.
26	19	18	P64	I	General-purpose input-only port This port is a hysteresis input type.
64	57	56	V_{CC}	—	Power supply pin
32, 57	25, 50	24, 49	V_{SS}	—	Power supply (GND) pins
19	12	11	AV_{CC}	—	A/D converter power supply pin
20	13	12	AVR	—	A/D converter reference voltage input pin
21	14	13	AV_{SS}	—	A/D converter power supply (GND) pin Use this pin at the same voltage as V_{SS}.

*1: DIP-64P-M01, DIP-64C-A06   *2: MDP-64C-P02   *3: FPT-64P-M06
*4: MQP-64C-P01   *5: FPT-64P-M03   *6: FPT-64P-M09
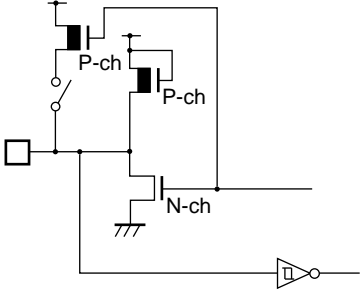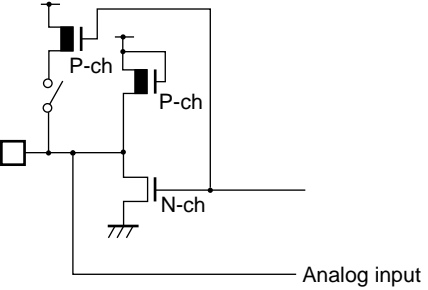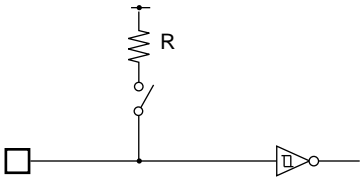
● **External EPROM pins (MB89PV620 only)**

Pin no.		Pin name	I/O	Function
MDIP[*1]	**MQFP**[*2]			
65	66	V$_{PP}$	O	"H" level output pin
66 67 68 69 70 71 72 73 74	67 68 69 70 71 72 73 74 75	A12 A7 A6 A5 A4 A3 A2 A1 A0	O	Address output pins
75 76 77	77 78 79	O1 O2 O3	I	Data input pins
78	80	V$_{SS}$	O	Power supply (GND) pin
79 80 81 82 83	82 83 84 85 86	O4 O5 O6 O7 O8	I	Data input pins
84	87	$\overline{CE}$	O	ROM chip enable pin Outputs "H" during standby.
85	88	A10	O	Address output pin
86	89	$\overline{OE}$	O	ROM output enable pin Outputs "L" at all times.
87 88 89	91 92 93	A11 A9 A8	O	Address output pins
90	94	A13	O	
91	95	A14	O	
92	96	V$_{CC}$	O	EPROM power supply pin
—	65 76 81 90	N.C.	—	Internally connected pins Be sure to leave them open.

*1: MDP-64C-P02
*2: MQP-64C-P01

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MB89620 Series

■ I/O CIRCUIT TYPE

Type	Circuit	Remarks
A	Standby control signal	• At an oscillation feedback resistor of approximately 1 MΩ/5.0 V
B		
C		• At an output pull-up resistor (P-ch) of approximately 50 kΩ/5.0 V
D		• CMOS output • CMOS input • Pull-up resistor optional (except P22 and P23)
E		• CMOS output • Hysteresis input • Pull-up resistor optional
F		• CMOS output

(Continued)

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Type	Circuit	Remarks
G		• N-ch open-drain output • Hysteresis input • Pull-up resistor optional (MB89623, MB89625, MB89626, and MB89627 only)
H		• N-ch open-drain output • Analog input • Pull-up resistor optional
I		• Hysteresis input • Pull-up resistor optional

MB89620 Series

■ HANDLING DEVICES

1. Preventing Latchup

Latchup may occur on CMOS ICs if voltage higher than V_{CC} or lower than V_{SS} is applied to input and output pins other than medium- to high-voltage pins or if higher than the voltage which shows on "1. Absolute Maximum Ratings" in section "■ Electrical Characteristics" is applied between V_{CC} and V_{SS}.

When latchup occurs, power supply current increases rapidly and might thermally damage elements. When using, take great care not to exceed the absolute maximum ratings.

Also, take care to prevent the analog power supply (AV_{CC} and AVR) and analog input from exceeding the digital power supply (V_{CC}) when the analog system power supply is turned on and off.

2. Treatment of Unused Input Pins

Leaving unused input pins open could cause malfunctions. They should be connected to a pull-up or pull-down resistor.

3. Treatment of Power Supply Pins on Microcontrollers with A/D and D/A Converters

Connect to be AV_{CC} = DAVC = V_{CC} and AV_{SS} = AVR = V_{SS} even if the A/D and D/A converters are not in use.

4. Treatment of N.C. Pins

Be sure to leave (internally connected) N.C. pins open.

5. Power Supply Voltage Fluctuations

Although V_{CC} power supply voltage is assured to operate within the rated range, a rapid fluctuation of the voltage could cause malfunctions, even if it occurs within the rated range. Stabilizing voltage supplied to the IC is therefore important. As stabilization guidelines, it is recommended to control power so that V_{CC} ripple fluctuations (P-P value) will be less than 10% of the standard V_{CC} value at the commercial frequency (50 to 60 Hz) and the transient fluctuation rate will be less than 0.1 V/ms at the time of a momentary fluctuation such as when power is switched.

6. Precautions when Using an External Clock

Even when an external clock is used, oscillation stabilization time is required for power-on reset (optional) and wake-up from stop mode.
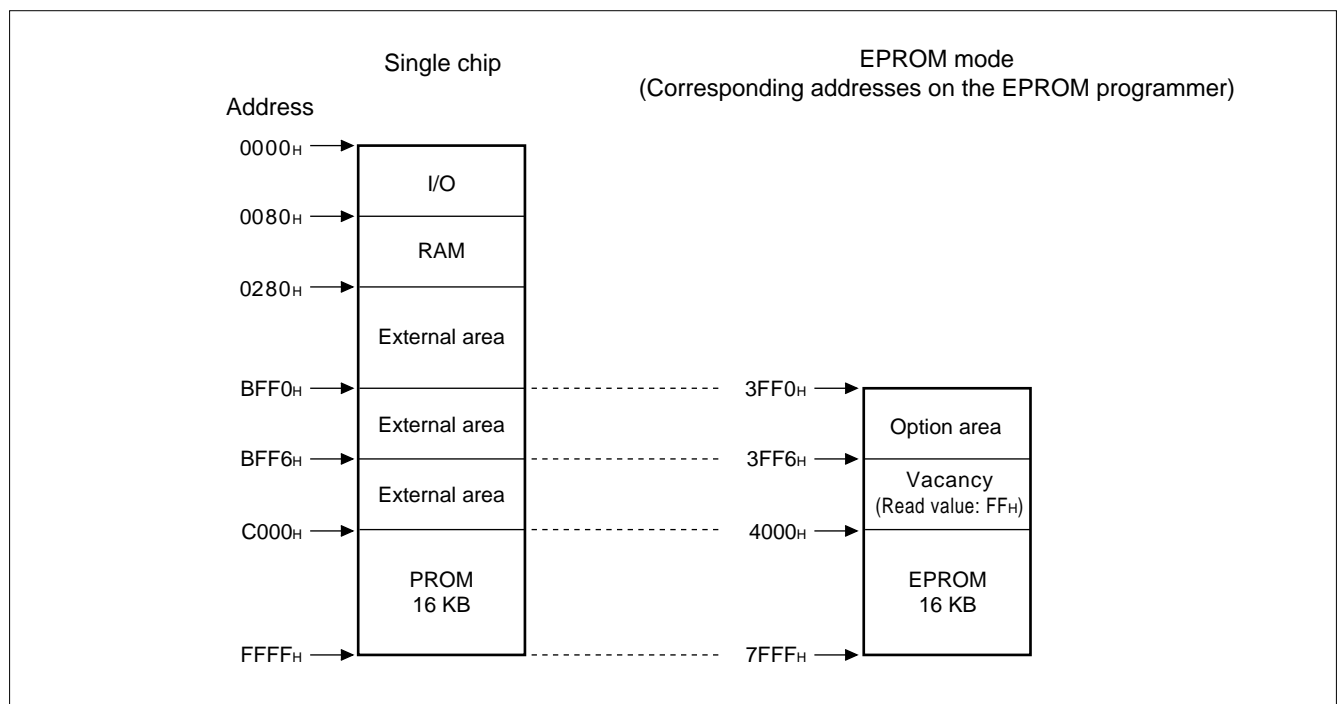
■ PROGRAMMING TO THE EPROM ON THE MB89P625

The MB89P625 is an OTPROM version of the MB89620 series.

1. Features

- 16-Kbyte PROM on chip
- Options can be set using the EPROM programmer.
- Equivalency to the MBM27C256A in EPROM mode (when programmed with the EPROM programmer)

2. Memory Space

Memory space in each mode such as 16-Kbyte PROM, option area is diagrammed below.

3. Programming to the EPROM

In EPROM mode, the MB89P625 functions equivalent to the MBM27C256A. This allows the PROM to be programmed with a general-purpose EPROM programmer (the electronic signature mode cannot be used) by using the dedicated socket adapter.

When the operating ROM area for a single chip is 16 Kbytes ($C000_H$ to $FFFF_H$) the PROM can be programmed as follows:

• Programming procedure

(1) Set the EPROM programmer to the MBM27C256A.

(2) Load program data into the EPROM programmer at 4000_H to $7FFF_H$ (note that addresses $C000_H$ to $FFFF_H$ while operating as a single chip assign to 4000_H to $7FFF_H$ in EPROM mode).
     Load option data into addresses $3FF0_H$ to $3FF6_H$ of the EPROM programmer. (For information about each corresponding option, see "4. Setting OTPROM Options.")

(3) Program to $3FF0_H$ to $7FFF_H$ with the EPROM programmer.

MB89620 Series

4. Setting OTPROM Options

The programming procedure is the same as that for the PROM. Options can be set by programming values at the addresses shown on the memory map.

The relationship between bits and options is shown on the following bit map:

• **OTPROM option bit map (MB89P625)**

	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
3FF0H	Vacancy Readable and writable	Vacancy Readable and writable	Vacancy Readable and writable	Vacancy Readable and writable	Vacancy Readable and writable	Reset pin output 1: Yes 0: No	Oscillation stabilization time 1: Crystal 0: Ceramic	Power-on reset 1: Yes 0: No
3FF1H	P07 Pull-up 1: No 0: Yes	P06 Pull-up 1: No 0: Yes	P05 Pull-up 1: No 0: Yes	P04 Pull-up 1: No 0: Yes	P03 Pull-up 1: No 0: Yes	P02 Pull-up 1: No 0: Yes	P01 Pull-up 1: No 0: Yes	P00 Pull-up 1: No 0: Yes
3FF2H	P17 Pull-up 1: No 0: Yes	P16 Pull-up 1: No 0: Yes	P15 Pull-up 1: No 0: Yes	P14 Pull-up 1: No 0: Yes	P13 Pull-up 1: No 0: Yes	P12 Pull-up 1: No 0: Yes	P11 Pull-up 1: No 0: Yes	P10 Pull-up 1: No 0: Yes
3FF3H	P37 Pull-up 1: No 0: Yes	P36 Pull-up 1: No 0: Yes	P35 Pull-up 1: No 0: Yes	P34 Pull-up 1: No 0: Yes	P33 Pull-up 1: No 0: Yes	P32 Pull-up 1: No 0: Yes	P31 Pull-up 1: No 0: Yes	P30 Pull-up 1: No 0: Yes
3FF4H	P57 Pull-up 1: No 0: Yes	P56 Pull-up 1: No 0: Yes	P55 Pull-up 1: No 0: Yes	P54 Pull-up 1: No 0: Yes	P53 Pull-up 1: No 0: Yes	P52 Pull-up 1: No 0: Yes	P51 Pull-up 1: No 0: Yes	P50 Pull-up 1: No 0: Yes
3FF5H	Vacancy Readable and writable	Vacancy Readable and writable	Vacancy Readable and writable	P64 Pull-up 1: No 0: Yes	P63 Pull-up 1: No 0: Yes	P62 Pull-up 1: No 0: Yes	P61 Pull-up 1: No 0: Yes	P60 Pull-up 1: No 0: Yes

Notes: • Set each bit to 1 to erase.
  • Do not write 0 to the vacant bit.
    The read value of the vacant bit is 1, unless 0 is written to it.

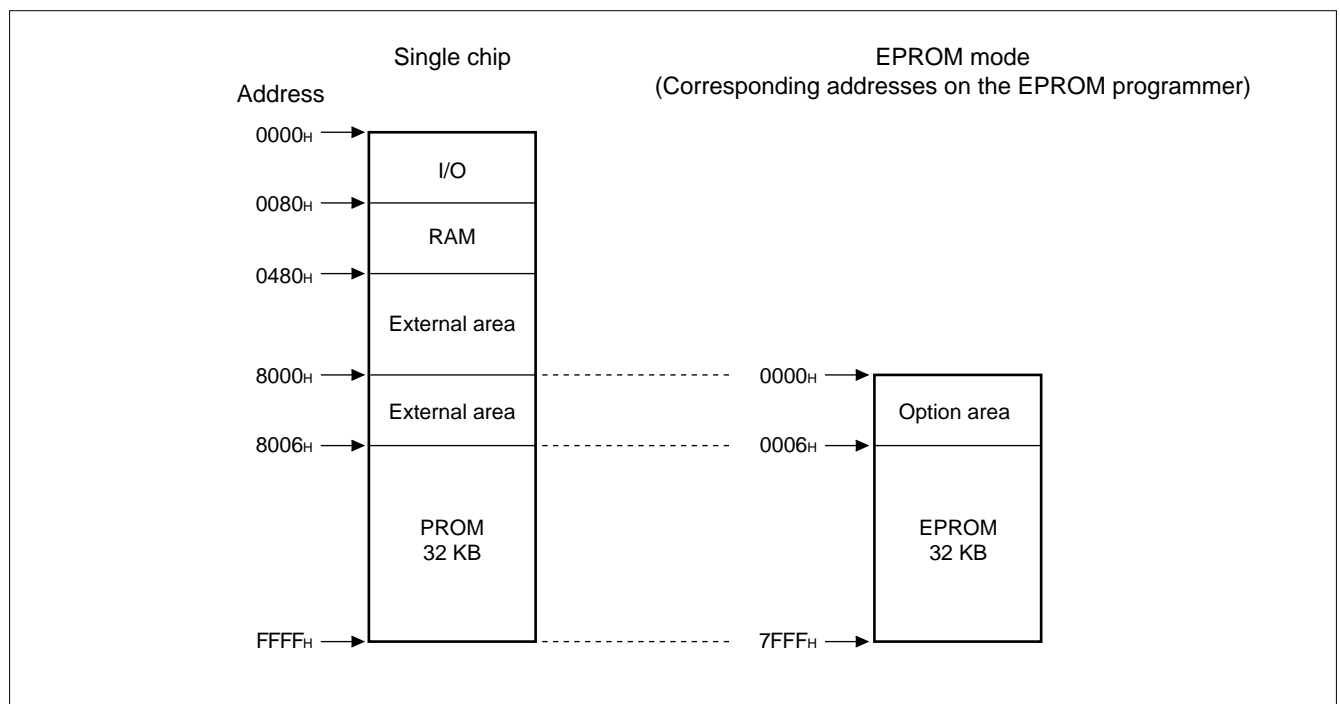## ■ PROGRAMMING TO THE EPROM ON THE MB89P627

The MB89P627 is an OTPROM version of the MB89620 series.

1. Features

- 32-Kbyte PROM on chip
- Options can be set using the EPROM programmer.
- Equivalency to the MBM27C256A in EPROM mode (when programmed with the EPROM programmer)

2. Memory Space

Memory space in each mode such as 32-Kbyte PROM, option area is diagrammed below.

3. Programming to the EPROM

In EPROM mode, the MB89P627 functions equivalent to the MBM27C256A. This allows the PROM to be programmed with a general-purpose EPROM programmer (the electronic signature mode cannot be used) by using the dedicated socket adapter.

When the operating ROM area for a single chip is 32 Kbytes (8006_H to $FFFF_H$) the PROM can be programmed as follows:

- **Programming procedure**

(1) Set the EPROM programmer to the MBM27C256A.

(2) Load program data into the EPROM programmer at 0006_H to $7FFF_H$ (note that addresses 8006_H to $FFFF_H$ while operating as a single chip assign to 0006_H to $7FFF_H$ in EPROM mode).
Load option data into addresses 0000_H to 0005_H of the EPROM programmer. (For information about each corresponding option, see "4. Setting OTPROM Options.")

(3) Program to 0000_H to $7FFF_H$ with the EPROM programmer.

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4. Setting OTPROM Options

The programming procedure is the same as that for the PROM. Options can be set by programming values at the addresses shown on the memory map.

The relationship between bits and options is shown on the following bit map:
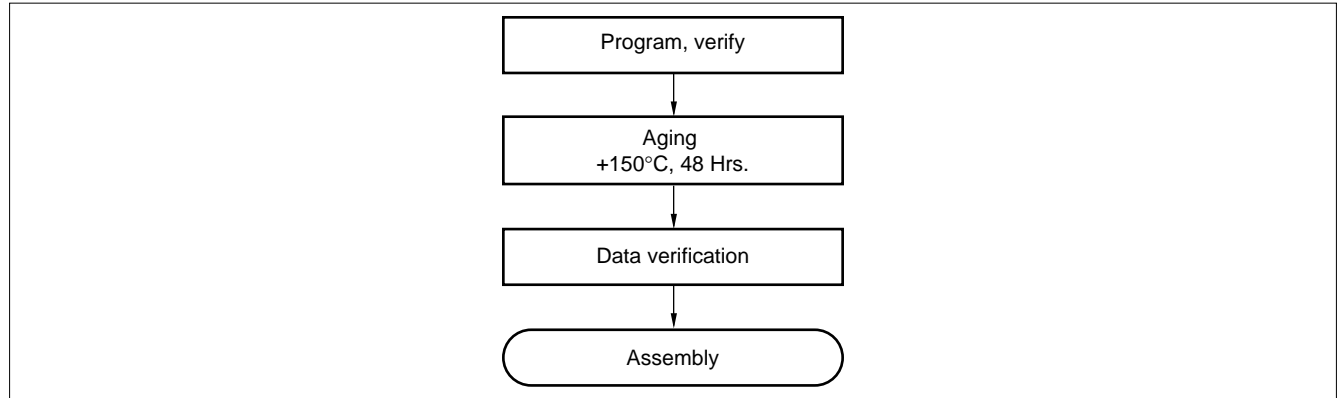
• **OTPROM option bit map (MB89P627)**

	Bit 7	**Bit 6**	**Bit 5**	**Bit 4**	**Bit 3**	**Bit 2**	**Bit 1**	**Bit 0**
0000H	Vacancy Readable and writable	Vacancy Readable and writable	Vacancy Readable and writable	Vacancy Readable and writable	Vacancy Readable and writable	Reset pin output 1: Yes 0: No	Oscillation stabilization time 1: Crystal 0: Ceramic	Power-on reset 1: Yes 0: No
0001H	P07 Pull-up 1: No 0: Yes	P06 Pull-up 1: No 0: Yes	P05 Pull-up 1: No 0: Yes	P04 Pull-up 1: No 0: Yes	P03 Pull-up 1: No 0: Yes	P02 Pull-up 1: No 0: Yes	P01 Pull-up 1: No 0: Yes	P00 Pull-up 1: No 0: Yes
0002H	P17 Pull-up 1: No 0: Yes	P16 Pull-up 1: No 0: Yes	P15 Pull-up 1: No 0: Yes	P14 Pull-up 1: No 0: Yes	P13 Pull-up 1: No 0: Yes	P12 Pull-up 1: No 0: Yes	P11 Pull-up 1: No 0: Yes	P10 Pull-up 1: No 0: Yes
0003H	P37 Pull-up 1: No 0: Yes	P36 Pull-up 1: No 0: Yes	P35 Pull-up 1: No 0: Yes	P34 Pull-up 1: No 0: Yes	P33 Pull-up 1: No 0: Yes	P32 Pull-up 1: No 0: Yes	P31 Pull-up 1: No 0: Yes	P30 Pull-up 1: No 0: Yes
0004H	P57 Pull-up 1: No 0: Yes	P56 Pull-up 1: No 0: Yes	P55 Pull-up 1: No 0: Yes	P54 Pull-up 1: No 0: Yes	P53 Pull-up 1: No 0: Yes	P52 Pull-up 1: No 0: Yes	P51 Pull-up 1: No 0: Yes	P50 Pull-up 1: No 0: Yes
0005H	Vacancy Readable and writable	Vacancy Readable and writable	Vacancy Readable and writable	P64 Pull-up 1: No 0: Yes	P63 Pull-up 1: No 0: Yes	P62 Pull-up 1: No 0: Yes	P61 Pull-up 1: No 0: Yes	P60 Pull-up 1: No 0: Yes
0006H	Vacancy Readable and writable	Vacancy Readable and writable	Vacancy Readable and writable	Vacancy Readable and writable	Vacancy Readable and writable	Vacancy Readable and writable	Vacancy Readable and writable	Vacancy Readable and writable

Notes: • Set each bit to 1 to erase.
  • Do not write 0 to the vacant bit.
  The read value of the vacant bit is 1, unless 0 is written to it.

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■ HANDLING THE MB89P625/P627

1. Recommended Screening Conditions

High-temperature aging is recommended as the pre-assembly screening procedure for a product with a blanked OTPROM microcomputer program.

```
┌─────────────────────┐
│   Program, verify   │
└─────────────────────┘
           │
           ▼
┌─────────────────────┐
│       Aging         │
│   +150°C, 48 Hrs.   │
└─────────────────────┘
           │
           ▼
┌─────────────────────┐
│  Data verification  │
└─────────────────────┘
           │
           ▼
     (    Assembly    )
```

2. Programming Yield

All bits cannot be programmed at Fujitsu shipping test to a blanked OTPROM microcomputer, due to its nature. For this reason, a programming yield of 100% cannot be assured at all times.

3. Erasure

In order to clear all locations of their programmed contents, it is necessary to expose the internal EPROM to an ultraviolet light source. A dosage of 10 W-seconds/cm^2 is required to completely erase an internal EPROM. This dosage can be obtained by exposure to an ultraviolet lamp (wavelength of 2537 Angstroms (Å)) with intensity of 12000 μW/cm^2 for 15 to 21 minutes. The internal EPROM should be about one inch from the source and all filters should be removed from the UV light source prior to erasure.

It is important to note that the internal EPROM and similar devices, will erase with light sources having wavelengths shorter than 4000Å. Although erasure time will be much longer than with UV source at 2537Å, nevertheless the exposure to fluorescent light and sunlight will eventually erase the internal EPROM, and exposure to them should be prevented to realize maximum system reliability. If used in such an environment, the package windows should be covered by an opaque label or substance.

4. EPROM Programmer Socket Adapter

Package	Compatible socket adapter
DIP-64C-M01	ROM-64SD-28DP-8L
FPT-64P-M06	ROM-64QF-28DP-8L
FPT-64P-M09	ROM-64QF2-28DP-8L

Inquiry: Sun Hayato Co., Ltd.: TEL 81-3-3802-5760

MB89620 Series

■ PROGRAMMING TO THE EPROM PIGGYBACK/EVALUATION DEVICE

1. EPROM for Use

MBM27C256A-20TV, MBM27C256A-20CZ
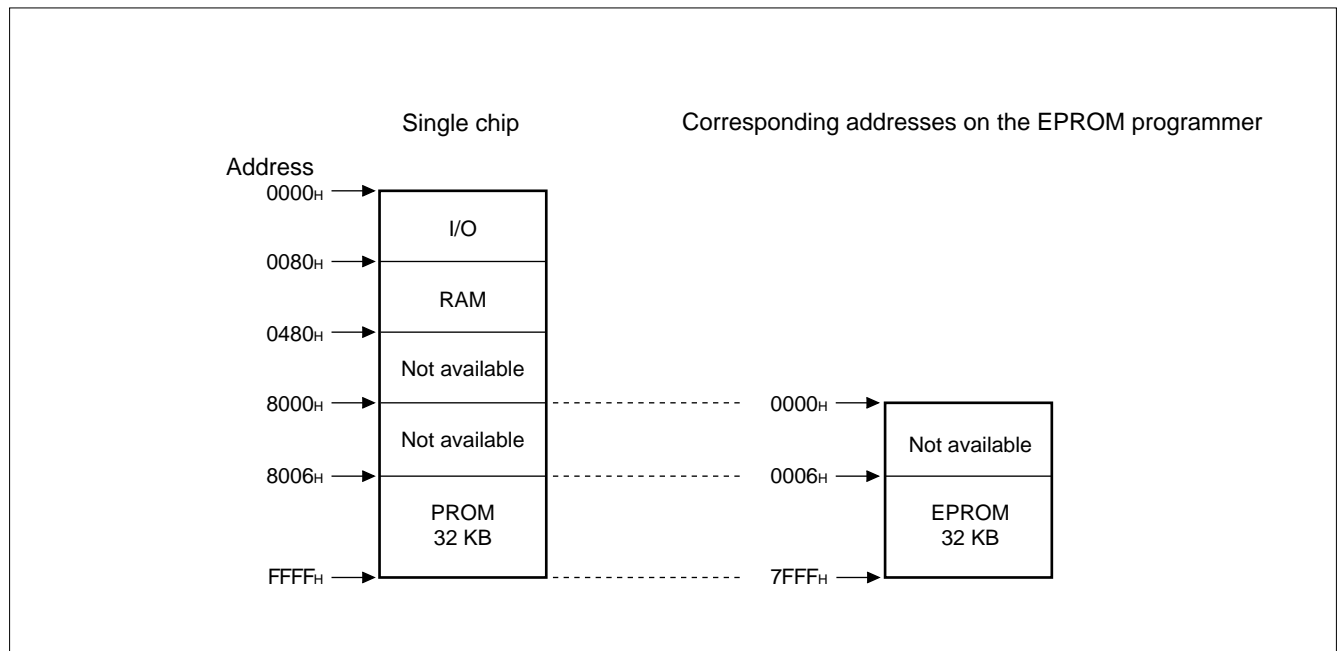
2. Programming Socket Adapter

To program to the PROM using an EPROM programmer, use the socket adapter (manufacturer: Sun Hayato Co., Ltd.) listed below.

Package	Adapter socket part number
LCC-32 (Rectangle)	ROM-32LC-28DP-YG
LCC-32 (Square)	ROM-32LC-28DP-2

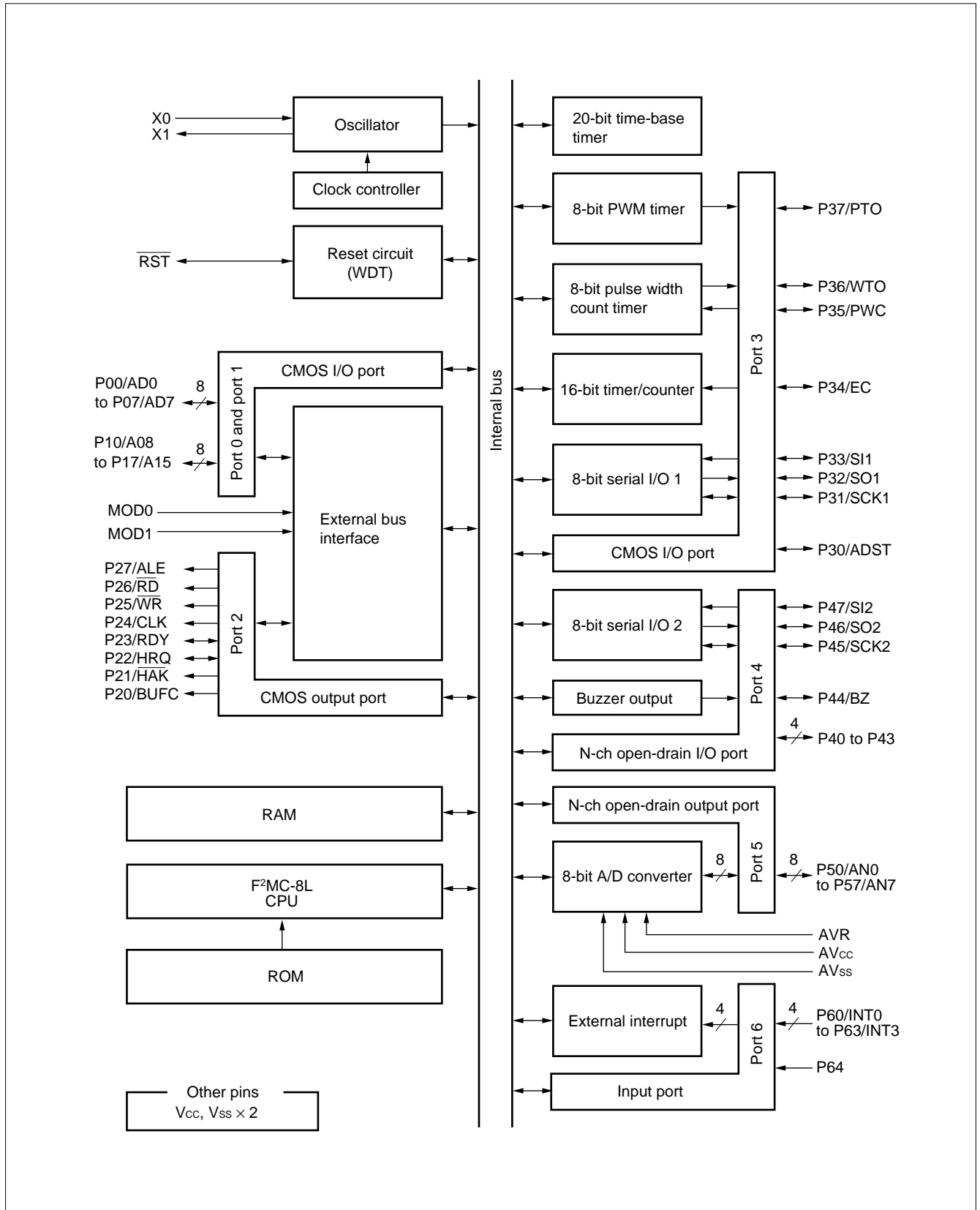Inquiry: Sun Hayato Co., Ltd.: TEL 81-3-3802-5760

3. Memory Space

Memory space in 32-Kbyte PROM is diagrammed below.

4. Programming to the EPROM

(1) Set the EPROM programmer to the MBM27C256A.
(2) Load program data into the EPROM programmer at 0006_H to $7FFF_H$.
(3) Program to 0000_H to $7FFF_H$ with the EPROM programmer.
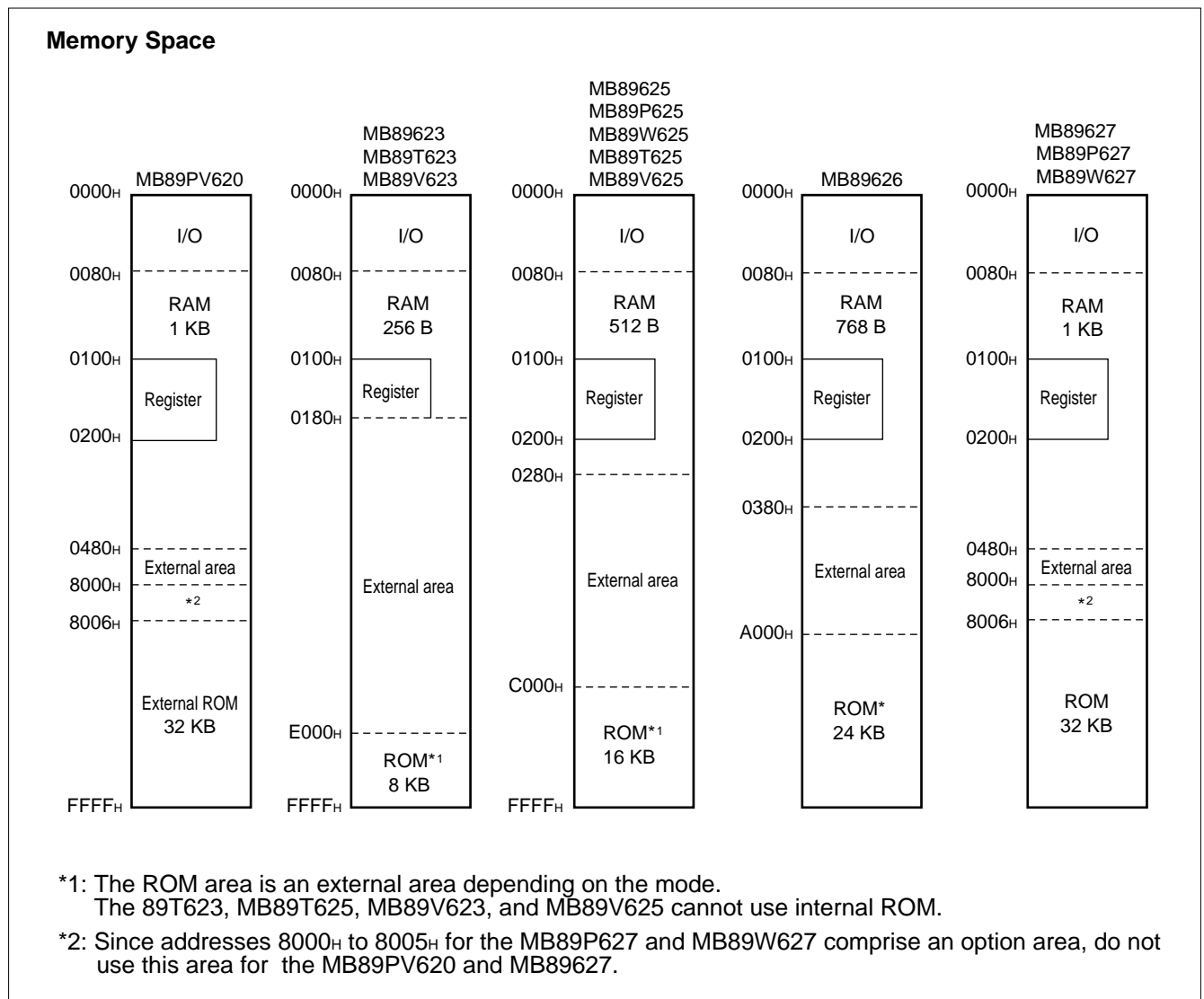
■ BLOCK DIAGRAM

MB89620 Series

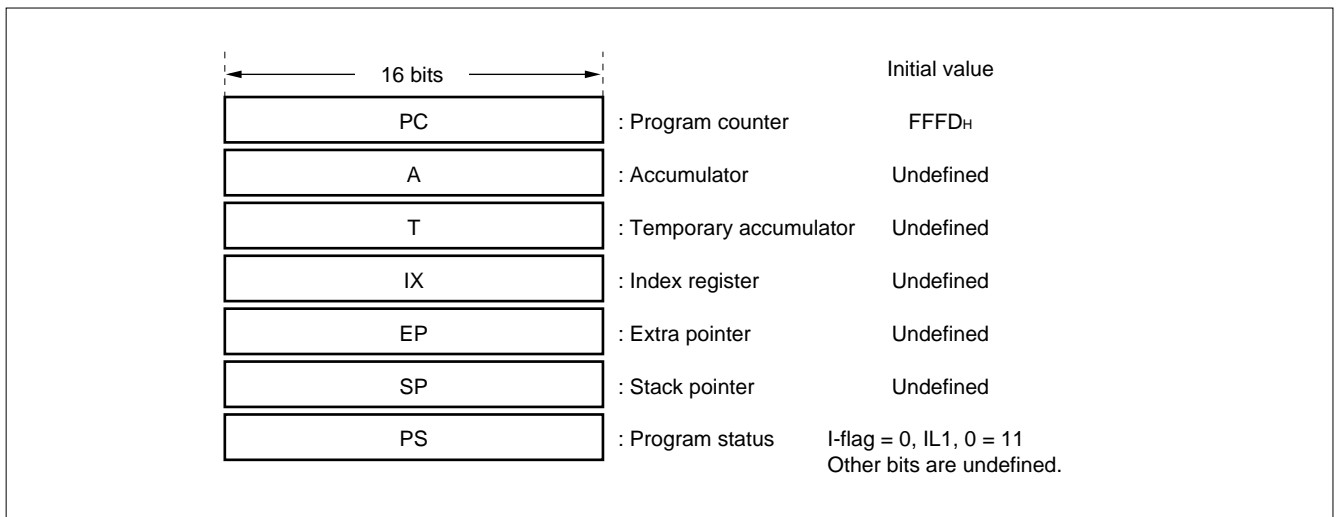## ■ CPU CORE

1. Memory Space

The microcontrollers of the MB89620 series offer a memory space of 64 Kbytes for storing all of I/O, data, and program areas. The I/O area is located at the lowest address. The data area is provided immediately above the I/O area. The data area can be divided into register, stack, and direct areas according to the application. The program area is located at exactly the opposite end, that is, near the highest address. Provide the tables of interrupt reset vectors and vector call instructions toward the highest address within the program area. The memory space of the MB89620 series is structured as illustrated below.

Memory Space

*1: The ROM area is an external area depending on the mode.
The 89T623, MB89T625, MB89V623, and MB89V625 cannot use internal ROM.

*2: Since addresses 8000H to 8005H for the MB89P627 and MB89W627 comprise an option area, do not use this area for the MB89PV620 and MB89627.
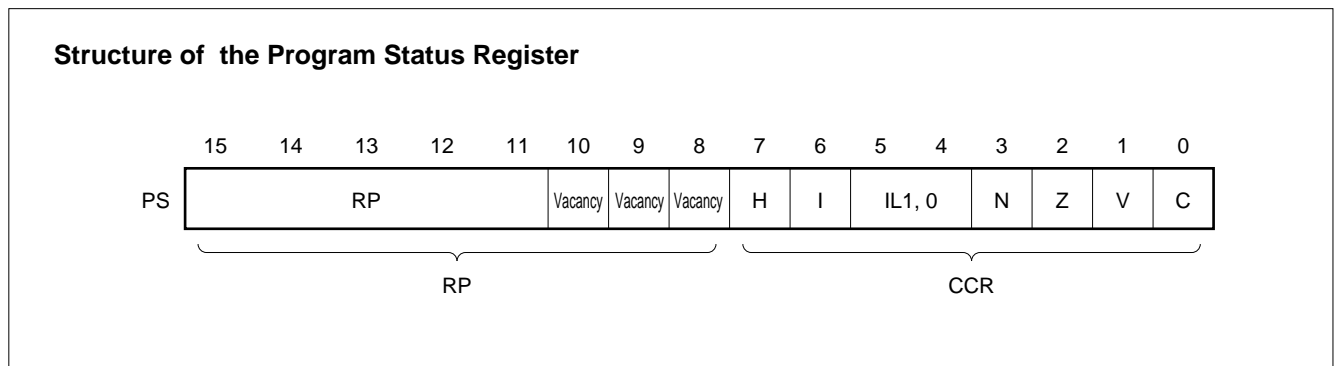
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2. Registers

The F^{2}MC-8L family has two types of registers; dedicated registers in the CPU and general-purpose registers in the memory. The following dedicated registers are provided:

Program counter (PC):   A 16-bit register for indicating instruction storage positions

Accumulator (A):   A 16-bit temporary register for storing arithmetic operations, etc. When the instruction is an 8-bit data processing instruction, the lower byte is used.

Temporary accumulator (T):   A 16-bit register which performs arithmetic operations with the accumulator When the instruction is an 8-bit data processing instruction, the lower byte is used.

Index register (IX):   A 16-bit register for index modification

Extra pointer (EP):   A 16-bit pointer for indicating a memory address

Stack pointer (SP):   A 16-bit register for indicating a stack area

Program status (PS):   A 16-bit register for storing a register pointer, a condition code

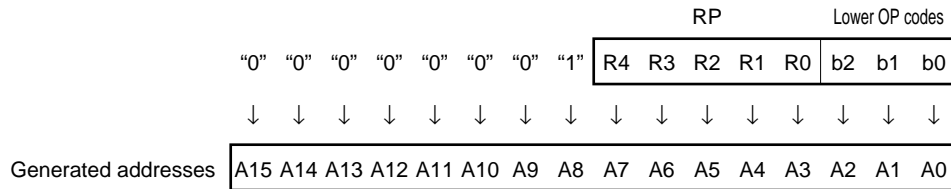|	16 bits	Initial value
PC	: Program counter	FFFD$_H$
A	: Accumulator	Undefined
T	: Temporary accumulator	Undefined
IX	: Index register	Undefined
EP	: Extra pointer	Undefined
SP	: Stack pointer	Undefined
PS	: Program status	I-flag = 0, IL1, 0 = 11 Other bits are undefined.

The PS can further be divided into higher 8 bits for use as a register bank pointer (RP) and the lower 8 bits for use as a condition code register (CCR). (See the diagram below.)

Structure of the Program Status Register

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
PS			RP			Vacancy	Vacancy	Vacancy	H	I	IL1, 0		N	Z	V	C

RP   CCR

MB89620 Series

The RP indicates the address of the register bank currently in use. The relationship between the pointer contents and the actual address is based on the conversion rule illustrated below.

Rule for Conversion of Actual Addresses of the General-purpose Register Area

								RP					Lower OP codes		
"0"	"0"	"0"	"0"	"0"	"0"	"0"	"1"	R4	R3	R2	R1	R0	b2	b1	b0
↓	↓	↓	↓	↓	↓	↓	↓	↓	↓	↓	↓	↓	↓	↓	↓

Generated addresses

| A15 | A14 | A13 | A12 | A11 | A10 | A9 | A8 | A7 | A6 | A5 | A4 | A3 | A2 | A1 | A0 |

The CCR consists of bits indicating the results of arithmetic operations and the contents of transfer data and bits for control of CPU operations at the time of an interrupt.

H-flag: Set when a carry or a borrow from bit 3 to bit 4 occurs as a result of an arithmetic operation. Cleared otherwise. This flag is for decimal adjustment instructions.

I-flag: Interrupt is allowed when this flag is set to 1. Interrupt is prohibited when the flag is set to 0. Set to 0 when reset.

IL1, 0: Indicates the level of the interrupt currently allowed. Processes an interrupt only if its request level is higher than the value indicated by this bit.

IL1	IL0	Interrupt level	High-low
0	0	1	High
0	1		↑
1	0	2	↓
1	1	3	Low = no interrupt

N-flag: Set if the MSB is set to 1 as the result of an arithmetic operation. Cleared when the bit is set to 0.

Z-flag: Set when an arithmetic operation results in 0. Cleared otherwise.

V-flag: Set if the complement on 2 overflows as a result of an arithmetic operation. Reset if the overflow does not occur.

C-flag: Set when a carry or a borrow from bit 7 occurs as a result of an arithmetic operation. Cleared otherwise. Set to the shift-out value in the case of a shift instruction.

The following general-purpose registers are provided:

General-purpose registers: An 8-bit register for storing data

The general-purpose registers are 8 bits and located in the register banks of the memory. One bank contains eight registers and up to a total of 32 banks can be used on the MB89620. In the MB89623, there are 16 banks in internal RAM. The remaining 16 banks can be extended externally by allocating an external RAM to addresses 0180$_H$ to 01FF$_H$ using an external circuit. The bank currently in use is indicated by the register bank pointer (RP).

Note: The number of register banks that can be used varies with the RAM size.

Register Bank Configuration

This address = 0100$_H$ + 8 × (RP)

| R 0 |
| R 1 |
| R 2 |
| R 3 |
| R 4 |
| R 5 |
| R 6 |
| R 7 |

32 banks

Memory area
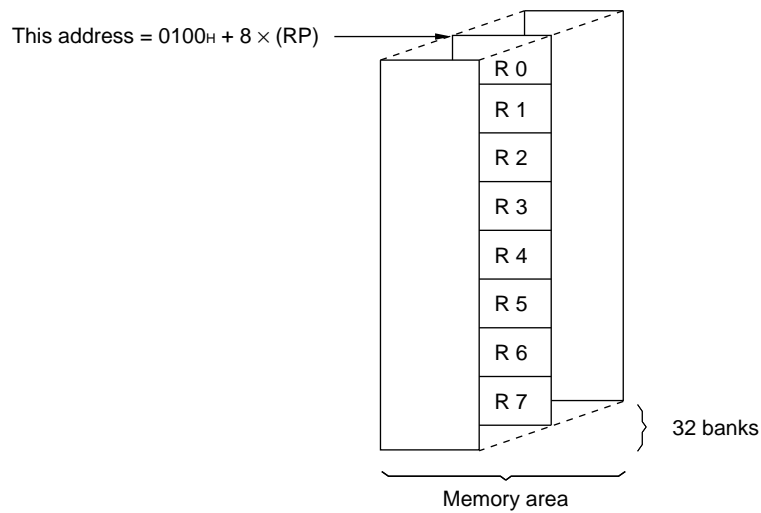
MB89620 Series

■ I/O MAP

Address	Read/write	Register name	Register description
00H	(R/W)	PDR0	Port 0 data register
01H	(W)	DDR0	Port 0 data direction register
02H	(R/W)	PDR1	Port 1 data register
03H	(W)	DDR1	Port 1 data direction register
04H	(R/W)	PDR2	Port 2 data register
05H	(R/W)	BCTR	External bus pin control register
06H			Vacancy
07H			Vacancy
08H	(R/W)	STBC	Standby control register
09H	(R/W)	WDTC	Watchdog timer control register
0AH	(R/W)	TBTC	Time-base timer control register
0BH			Vacancy
0CH	(R/W)	PDR3	Port 3 data register
0DH	(W)	DDR3	Port 3 data direction register
0EH	(R/W)	PDR4	Port 4 data register
0FH	(R/W)	BZCR	Buzzer register
10H	(R/W)	PDR5	Port 5 data register
11H	(R)	PDR6	Port 6 data register
12H	(R/W)	CNTR	PWM control register 1
13H	(W)	COMR	PWM compare register
14H	(R/W)	PCR1	PWC pulse width control register 1
15H	(R/W)	PCR2	PWC pulse width control register 2
16H	(R/W)	RLBR	PWC reload buffer register
17H			Vacancy
18H	(R/W)	TMCR	16-bit timer control register
19H	(R/W)	TCHR	16-bit timer count register (H)
1AH	(R/W)	TCLR	16-bit timer count register (L)
1BH			Vacancy
1CH	(R/W)	SMR1	Serial I/O 1 mode register
1DH	(R/W)	SDR1	Serial I/O 1 data register
1EH	(R/W)	SMR2	Serial I/O 2 mode register
1FH	(R/W)	SDR2	Serial I/O 2 data register

(Continued)

(Continued)

Address	Read/write	Register name	Register description
20$_H$	(R/W)	ADC1	A/D converter control register 1
21$_H$	(R/W)	ADC2	A/D converter control register 2
22$_H$	(R/W)	ADCD	A/D converter data register
23$_H$			Vacancy
24$_H$	(R/W)	EIC1	External interrupt control register 1
25$_H$	(R/W)	EIC2	External interrupt control register 2
26$_H$ to 7B$_H$			Vacancy
7C$_H$	(W)	ILR1	Interrupt level setting register 1
7D$_H$	(W)	ILR2	Interrupt level setting register 2
7E$_H$	(W)	ILR3	Interrupt level setting register 3
7F$_H$			Vacancy

Note: Do not use vacancies.

MB89620 Series

■ ELECTRICAL CHARACTERISTICS

1. Absolute Maximum Ratings

$(AV_{SS} = V_{SS} = 0.0 \text{ V})$

Parameter	Symbol	Value		Unit	Remarks
		Min.	Max.		
Power supply voltage	V_{CC} AV_{CC}	$V_{SS} - 0.3$	$V_{SS} + 7.0$	V	*1
A/D converter reference input voltage	AVR	$V_{SS} - 0.3$	$V_{SS} + 7.0$	V	AVR must not exceed $AV_{CC} + 0.3$ V.
Input voltage	V_I	$V_{SS} - 0.3$	$V_{CC} + 0.3$	V	Except P40 to P47*2
	V_{I2}	$V_{SS} - 0.3$	$V_{SS} + 7.0$	V	P40 to P47
Output voltage	V_O	$V_{SS} - 0.3$	$V_{CC} + 0.3$	V	Except P40 to P47*2
	V_{O2}	$V_{SS} - 0.3$	$V_{SS} + 7.0$	V	P40 to P47
"L" level maximum output current	I_{OL}	—	20	mA	
"L" level average output current	I_{OLAV}	—	4	mA	Average value (operating current × operating rate)
"L" level total maximum output current	ΣI_{OL}	—	100	mA	
"L" level total average output current	ΣI_{OLAV}	—	40	mA	Average value (operating current × operating rate)
"H" level maximum output current	I_{OH}	—	−20	mA	
"H" level average output current	I_{OHAV}	—	−4	mA	Average value (operating current × operating rate)
"H" level total maximum output current	ΣI_{OH}	—	−50	mA	
"H" level total average output current	ΣI_{OHAV}	—	−20	mA	Average value (operating current × operating rate)
Power consumption	P_D	—	300	mW	
Operating temperature	T_A	−40	+85	°C	
Storage temperature	Tstg	−55	+150	°C	

*1: Use AV_{CC} and V_{CC} set at the same voltage.
   Take care so that AV_{CC} does not exceed V_{CC}, such as when power is turned on.

*2: V_I and V_O must not exceed $V_{CC} + 0.3$ V.

Precautions: Permanent device damage may occur if the above "Absolute Maximum Ratings" are exceeded. Functional operation should be restricted to the conditions as detailed in the operational sections of this data sheet. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2. Recommended Operating Conditions

$(AV_{SS} = V_{SS} = 0.0\ V)$

Parameter	Symbol	Value		Unit	Remarks
		Min.	Max.		
Power supply voltage	V_{CC} AV_{CC}	2.2*	6.0*	V	Normal operation assurance range* (MB89623/625/626/627)
		2.7*	6.0*	V	Normal operation assurance range* (MB89T623/V623/T625/V625/P625/ W625/P627/W627/PV620)
		1.5	6.0	V	Retains the RAM state in stop mode
A/D converter reference input voltage	AVR	0.0	AV_{CC}	V	
Operating temperature	T_A	−40	+85	°C	

*: These values vary with the operating frequency and analog assurance range. See Figure 1 and "5. A/D Converter Electrical Characteristics."
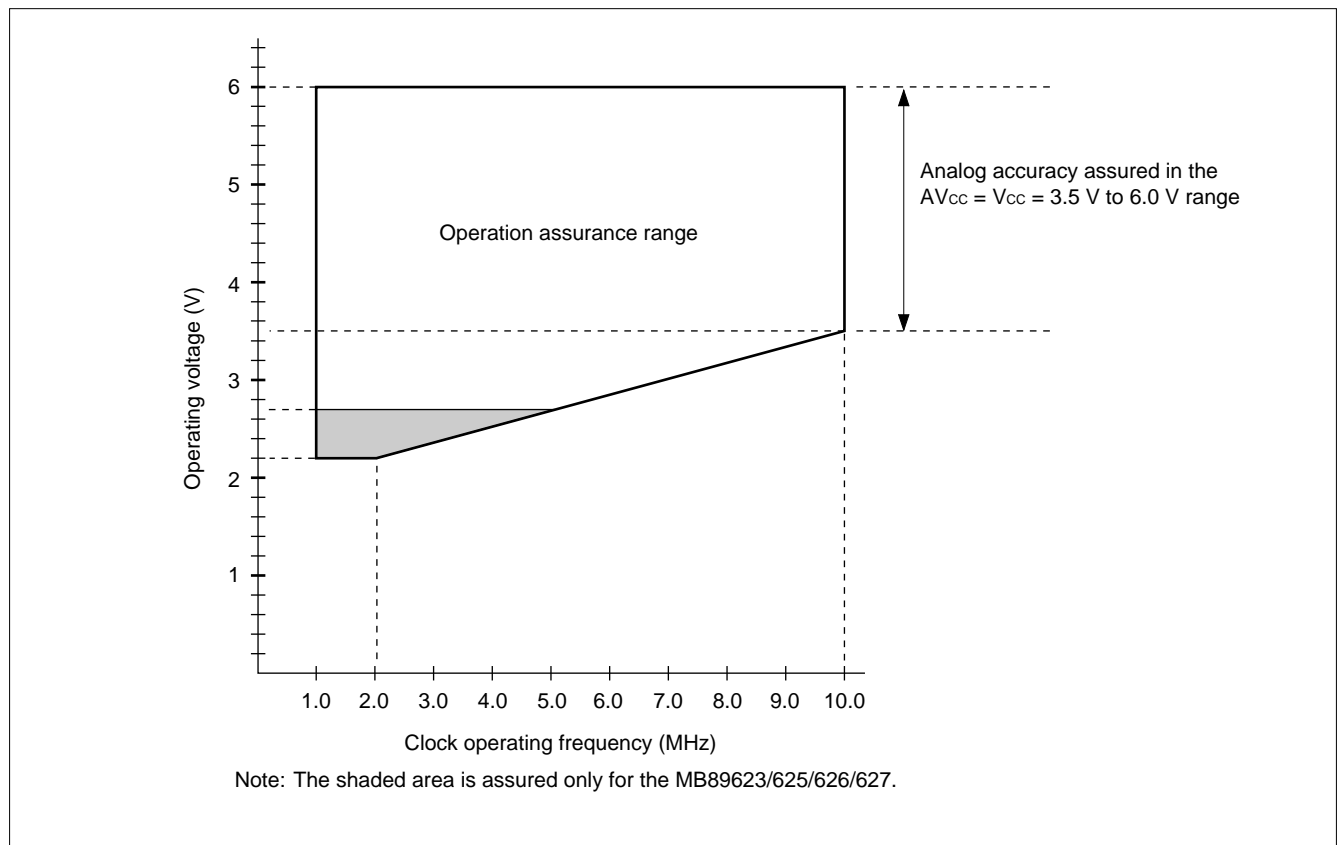
Figure 1   Operating Voltage vs. Clock Operating Frequency

Figure 1 indicates the operating frequency of the external oscillator at an instruction cycle of 4/F_C.

MB89620 Series

3. DC Characteristics

$(AV_{CC} = V_{CC} = 5.0\ V,\ AV_{SS} = V_{SS} = 0.0\ V,\ T_A = -40°C\ to\ +85°C)$

Parameter	Symbol	Pin	Condition	Min.	Typ.	Max.	Unit	Remarks
"H" level input voltage	V_{IH}	P00 to P07, P10 to P17, P22, P23	—	$0.7\ V_{CC}$	—	$V_{CC} + 0.3$	V	
	V_{IHS}	$\overline{RST}$, MOD0, MOD1, P30 to P37, P60 to P64	—	$0.8\ V_{CC}$	—	$V_{CC} + 0.3$	V	
	V_{IHS2}	P40 to P47	—	$0.8\ V_{CC}$	—	$V_{CC} + 0.3$	V	
"L" level input voltage	V_{IL}	P00 to P07, P10 to P17, P22, P23	—	$V_{SS} - 0.3$	—	$0.3\ V_{CC}$	V	
	V_{ILS}	$\overline{RST}$, MOD0, MOD1, P30 to P37, P40 to P47, P60 to P64	—	$V_{SS} - 0.3$	—	$0.2\ V_{CC}$	V	
Open-drain output pin application voltage	V_D	P50 to P57	—	$V_{SS} - 0.3$	—	$V_{CC} + 0.3$	V	
	V_{D2}	P40 to P47	—	$V_{SS} - 0.3$	—	$V_{SS} + 6.0$	V	
"H" level output voltage	V_{OH}	P00 to P07, P10 to P17, P20 to P27, P30 to P37	$I_{OH} = -2.0\ mA$	4.0	—	—	V	
"L" level output voltage	V_{OL}	P00 to P07, P10 to P17, P20 to P27, P30 to P37, P40 to P47, P50 to P57	$I_{OL} = +4.0\ mA$	—	—	0.4	V	
	V_{OL2}	$\overline{RST}$		—	—	0.4	V	
Input leakage current (Hi-z output leakage current)	I_{LI1}	P00 to P07, P10 to P17, P20 to P27, P30 to P37, P40 to P47, P60 to P64, MOD0, MOD1	$0.0\ V < V_I < V_{CC}$	—	—	±5	μA	Without pull-up resistor
Pull-up resistance	R_{PULL}	P00 to P07, P10 to P17, P30 to P37, P40 to P47, P50 to P57, P60 to P64, $\overline{RST}$	$V_I = 0.0\ V$	25	50	100	kΩ	

(Continued)

(Continued)

$(AV_{CC} = V_{CC} = 5.0\ V,\ AV_{SS} = V_{SS} = 0.0\ V,\ T_A = -40°C\ to\ +85°C)$

Parameter	Symbol	Pin	Condition	Value			Unit	Remarks
				Min.	Typ.	Max.		
Power supply current[1]	I_{CC}	V_{CC}	F_C = 10 MHz Normal operating mode t_{inst}[2] = 0.4 μs	—	9	15	mA	MB89623/625/ 627/V623/ T623/V625/ T625/PV620
				—	10	18	mA	MB89P625/ W625 MB89P627/ W627
	I_{CCS}		F_C = 10 MHz Sleep mode t_{inst}[2] = 0.4 μs	—	3	4	mA	
	I_{CCH}		Stop mode T_A = +25°C	—	—	1	μA	
	I_A		F_C = 10 MHz, when A/D conversion is activated	—	1	3	mA	
	I_{AH}	AV_{CC}	F_C = 10 MHz, T_A = +25°C, when A/D conversion is stopped	—	—	1	μA	
Input capacitance	C_{IN}	Other than AV_{CC}, AV_{SS}, V_{CC}, and V_{SS}	f = 1 MHz	—	10	—	pF	

*1: In the case of the MB89PV620, the current consumed by the connected EPROM and ICE is not included. The power supply current is measured at the external clock.

*2: For information on t_{inst}, see "(4) Instruction Cycle" in "4. AC Characteristics."
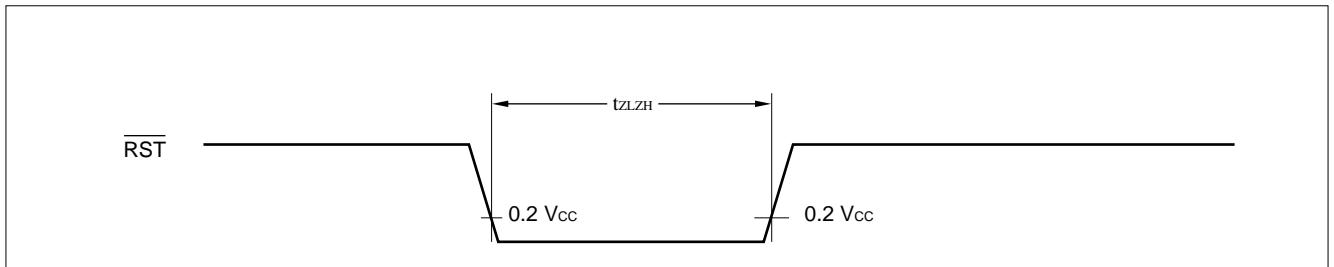
MB89620 Series

4. AC Characteristics

(1) Reset Timing

$(V_{CC} = +5.0 \text{ V} \pm 10\%, AV_{SS} = V_{SS} = 0.0 \text{ V}, T_A = -40°C \text{ to } +85°C)$

Parameter	Symbol	Condition	Value		Unit	Remarks
			Min.	Max.		
$\overline{\text{RST}}$ "L" pulse width	t_{ZLZH}	—	16 t_{XCYL}	—	ns	

Note: t_{XCYL} is the oscillation cycle ($1/F_C$) to input to the X0 pin.

(2) Power-on Reset

$(AV_{SS} = V_{SS} = 0.0 \text{ V}, T_A = -40°C \text{ to } +85°C)$

Parameter	Symbol	Condition	Value		Unit	Remarks
			Min.	Max.		
Power supply rising time	t_R	—	—	50	ms	Power-on reset function only
Power supply cut-off time	t_{OFF}		1	—	ms	Due to repeated operations

Note: Make sure that power supply rises within the selected oscillation stabilization time.
If power supply voltage needs to be varied in the course of operation, a smooth voltage rise is recommended.
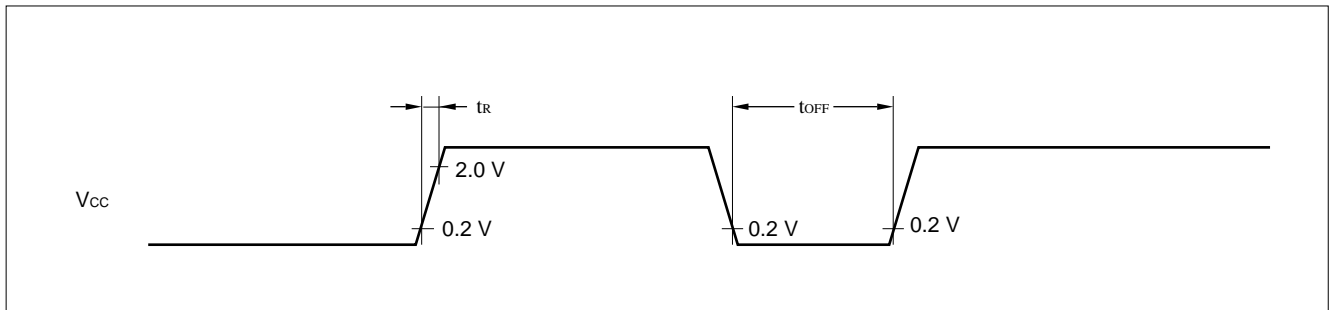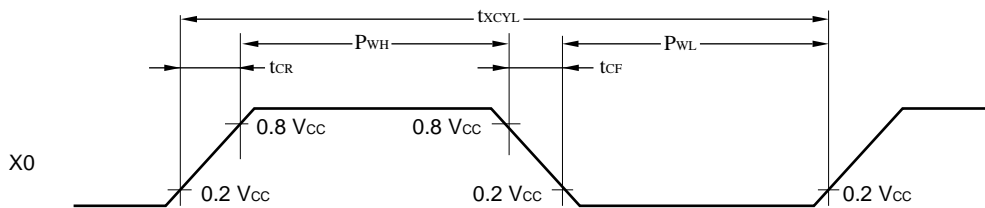
(3) Clock Timing

(AV$_{SS}$ = V$_{SS}$ = 0.0 V, T$_A$ = −40°C to +85°C)

Parameter	Symbol	Pin	Condition	Value Min.	Value Max.	Unit	Remarks
Clock frequency	F$_C$	X0, X1		1	10	MHz	
Clock cycle time	t$_{XYCL}$	X0, X1		100	1000	ns	
Input clock pulse width	P$_{WH}$ P$_{WL}$	X0	—	20	—	ns	External clock
Input clock rising/falling time	t$_{CR}$ t$_{CF}$	X0		—	10	ns	External clock

X0 and X1 Timing and Conditions

Clock Conditions
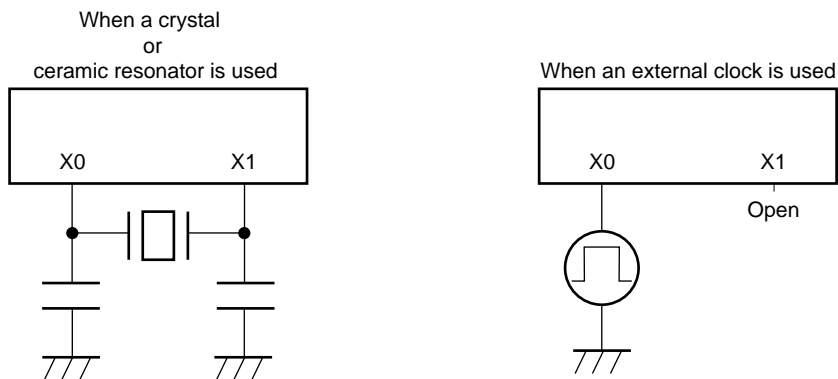
(4) Instruction Cycle

Parameter	Symbol	Value (typical)	Unit	Remarks
Instruction cycle (minimum execution time)	t$_{inst}$	4/F$_C$	μs	t$_{inst}$ = 0.4 μs when operating at F$_C$ = 10 MHz

MB89620 Series

(5) Recommended Resonator Manufacturers

Sample Application of Piezoelectric Resonator (FAR Series)

X 0   X 1

FAR*
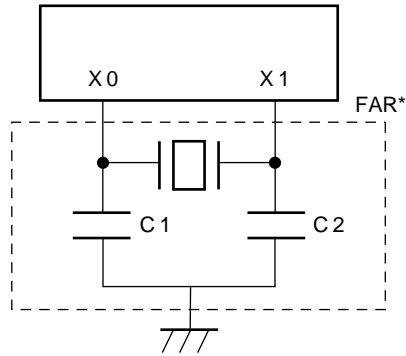
C 1   C 2

*: Fujitsu Acoustic Resonator
  C1 = C2 = 20pF±8 pF (built-in FAR)

FAR part number (built-in capacitor type)	Frequency	Initial deviation of FAR frequency (T_A = +25°C)	Temperature characteristics of FAR frequency (T_A = −20°C to +60°C)
FAR-C4CB-08000-M02	8.00 MHz	±0.5%	±0.5%
FAR-C4CB-10000-M02	10.00 MHz	±0.5%	±0.5%

Inquiry: FUJITSU LIMITED

Sample Application of Ceramic Resonator

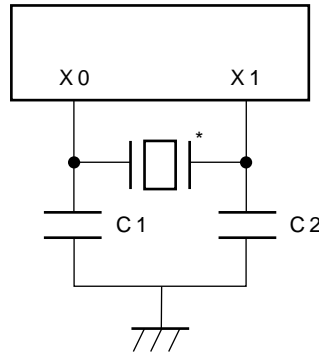| Resonator manufacturer*	Resonator	Frequency	C1 (pF)	C2 (pF)	R (kΩ)
Kyocera Corporation	KBR-7.68MWS	7.68 MHz	33	33	—
	KBR-8.0MWS	8.0 MHz	33	33	—
Murata Mfg. Co., Ltd.	CSA8.00MTZ	8.0 MHz	30	30	—

Inquiry: Kyocera Corporation
- AVX Corporation
  North American Sales Headquarters: TEL 1-803-448-9411
- AVX Limited
  European Sales Headquarters: TEL 44-1252-770000
- AVX/Kyocera H.K. Ltd.
  Asian Sales Headquarters: TEL 852-363-3303
Murata Mfg. Co., Ltd.
- Murata Electronics North America, Inc.: TEL 1-404-436-1300
- Murata Europe Management GmbH: TEL 49-911-66870
- Murata Electronics Singapore (Pte.) Ltd.: TEL 65-758-4233

(6) Clock Output Timing

(V_{CC} = +5.0 V±10%, AV_{SS} = V_{SS}= 0.0 V, T_A = −40°C to +85°C)

Parameter	Symbol	Pin	Condition	Value		Unit	Remarks
				Min.	Max.		
Cycle time	t_{CYC}	CLK	—	200	—	ns	$t_{XCYL} \times 2$ at 10 MHz oscillation
CLK $\uparrow \rightarrow$ CLK $\downarrow$	t_{CHCL}			30	100	ns	Approx. $t_{CYC}/2$ at 10 MHz oscillation
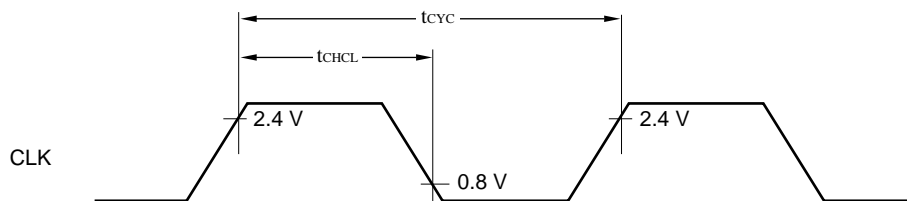
MB89620 Series

(7) Bus Read Timing

(Vcc = +5.0 V±10%, Fc = 10 MHz, AVss = Vss = 0.0 V, TA = −40°C to +85°C)

Parameter	Symbol	Pin	Condition	Value Min.	Value Max.	Unit	Remarks
Valid address → $\overline{RD}$ ↓ time	t_{AVRL}	$\overline{RD}$, A15 to A08, AD7 to AD0		1/4 t_{inst}*− 64 ns	—	μs	
$\overline{RD}$ pulse width	t_{RLRH}	$\overline{RD}$		1/2 t_{inst}*− 20 ns	—	μs	
Valid address → data read time	t_{AVDV}	AD7 to AD0, A15 to A08		—	1/2 t_{inst}*	μs	No wait
$\overline{RD}$ ↓ → data read time	t_{RLDV}	$\overline{RD}$, AD7 to AD0		—	1/2 t_{inst}*− 80 ns	μs	No wait
$\overline{RD}$ ↑ → data hold time	t_{RHDX}	AD7 to AD0, $\overline{RD}$		0	—	μs	
$\overline{RD}$ ↑ → ALE ↑ time	t_{RHLH}	$\overline{RD}$, ALE	—	1/4 t_{inst}*− 40 ns	—	μs	
$\overline{RD}$ ↑ → address invalid time	t_{RHAX}	$\overline{RD}$, A15 to A08		1/4 t_{inst}*− 40 ns	—	μs	
$\overline{RD}$ ↓ → CLK ↑ time	t_{RLCH}	$\overline{RD}$, CLK		1/4 t_{inst}*− 40 ns	—	μs	
CLK ↓ → $\overline{RD}$ ↑ time	t_{CLRH}			0	—	ns	
$\overline{RD}$ ↓ → BUFC ↓ time	t_{RLBL}	$\overline{RD}$, BUFC		−5	—	μs	
BUFC ↑ → valid address time	t_{BHAV}	A15 to A08, AD7 to AD0, BUFC		5	—	μs	

*: For information on t_{inst}, see "(4) Instruction Cycle."

(8) Bus Write Timing

$(V_{CC} = +5.0\ V\pm10\%,\ F_C = 10\ MHz,\ AV_{SS} = V_{SS} = 0.0\ V,\ T_A = -40°C\ to\ +85°C)$

Parameter	Symbol	Pin	Condition	Value		Unit	Remarks
				Min.	Max.		
Valid address → ALE ↓ time	t_{AVLL}	AD7 to AD0, ALE, A15 to A08		1/4 t_{inst}[1]– 64 ns	—	µs	
ALE ↓ time → address invalid time	t_{LLAX}	AD7 to AD0, ALE, A15 to A08		5	—	ns	
Valid address → $\overline{WR}$ ↓ time	t_{AVWL}	$\overline{WR}$, ALE		1/4 t_{inst}[1]– 60 ns	—	µs	
$\overline{WR}$ pulse width	t_{WLWH}	$\overline{WR}$		1/2 t_{inst}[1]– 20 ns	—	µs	
Write data → $\overline{WR}$ ↑ time	t_{DVWH}	AD7 to AD0, $\overline{WR}$		1/2 t_{inst}[1]– 60 ns	—	µs	
$\overline{WR}$ ↑ → address invalid time	t_{WHAX}	$\overline{WR}$, A15 to A08	—	1/4 t_{inst}[1]– 40 ns	—	ns	
$\overline{WR}$ ↑ → data hold time	t_{WHDX}	AD7 to AD0, $\overline{WR}$		1/4 t_{inst}[1]– 40 ns	—	µs	
$\overline{WR}$ ↑ → ALE ↑ time	t_{WHLH}	$\overline{WR}$, ALE		1/4 t_{inst}[1]– 40 ns	—	µs	
$\overline{WR}$ ↓ → CLK ↑ time	t_{WLCH}	$\overline{WR}$, CLK		1/4 t_{inst}[1]– 40 ns	—	µs	
CLK ↓ → $\overline{WR}$ ↑ time	t_{CLWH}			0	—	ns	
ALE pulse width	t_{LHLL}	ALE		1/4 t_{inst}[1]– 35 ns[2]	—	µs	
ALE ↓ → CLK ↑ time	t_{LLCH}	ALE, CLK		1/4 t_{inst}[1]– 30 ns[2]	—	µs	

[1]: For information on t_{inst}, see "(4) Instruction Cycle."

[2]: These characteristics are also applicable to the bus read timing.

MB89620 Series

(9) Ready Input Timing

(Vcc = +5.0 V±10%, Fc = 10 MHz, AVss = Vss= 0.0 V, TA = −40°C to +85°C)

Parameter	Symbol	Pin	Condition	Value		Unit	Remarks
				Min.	Max.		
RDY valid → CLK ↑ time	tYVCH	RDY, CLK	—	60	—	ns	*
CLK ↑ → RDY invalid time	tCHYX			0	—	ns	*

*: These characteristics are also applicable to the read cycle.

Note: The bus cycle is also extended in the read cycle in the same manner.

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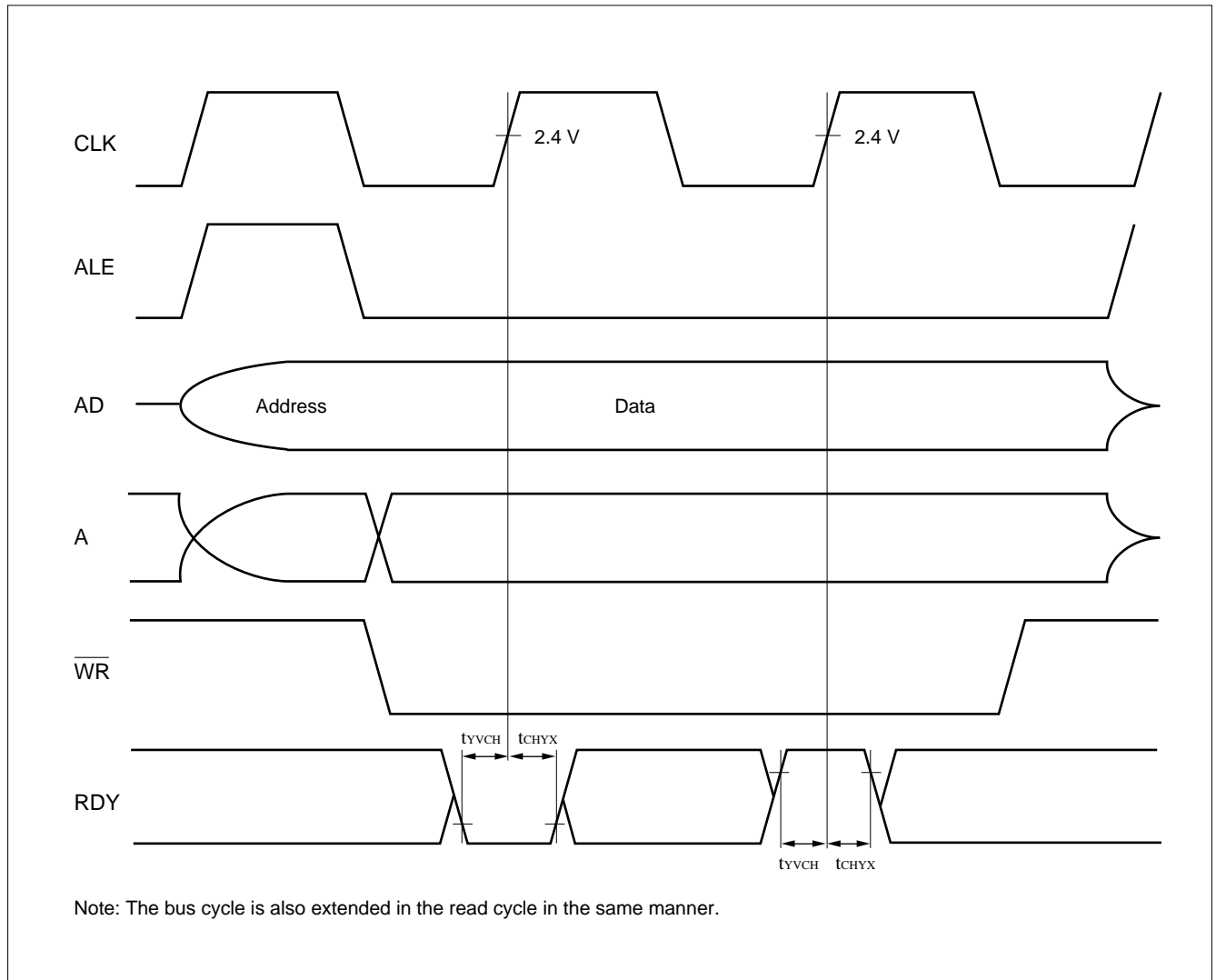
(10) Serial I/O Timing

$(V_{CC} = +5.0 \text{ V} \pm 10\%, AV_{SS} = V_{SS} = 0.0 \text{ V}, T_A = -40°C \text{ to } +85°C)$

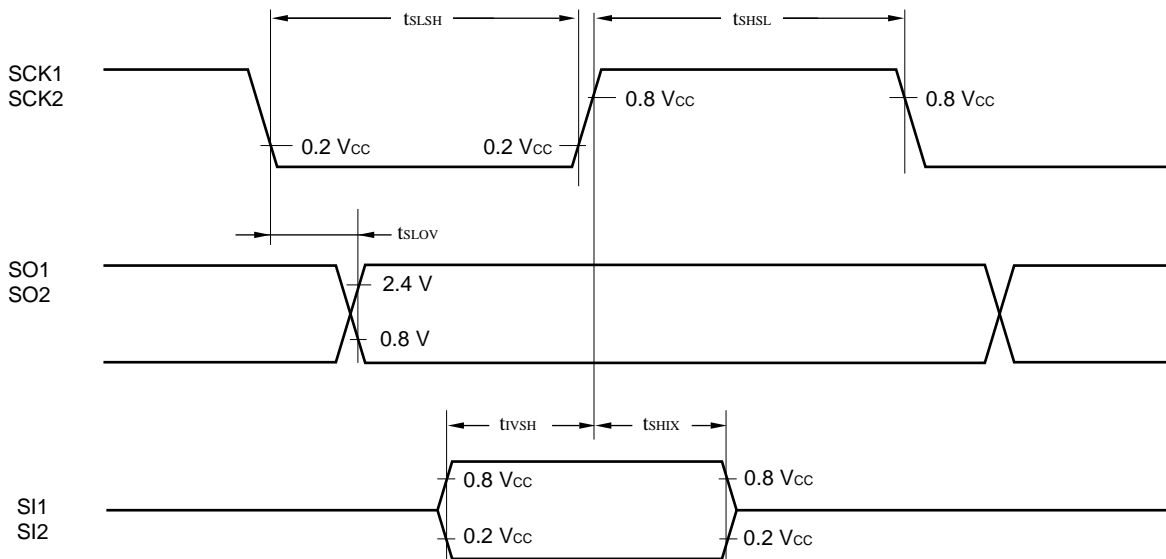| Parameter	Symbol	Pin	Condition	Value Min.	Value Max.	Unit	Remarks
Serial clock cycle time	t_{SCYC}	SCK1, SCK2	Internal shift clock mode	$2\ t_{inst}$*	—	µs	
SCK1 ↓ → SO1 time SCK2 ↓ → SO2 time	t_{SLOV}	SCK1, SO1 SCK2, SO2		−200	200	ns	
Valid SI1 → SCK1 ↑ Valid SI2 → SCK2 ↑	t_{IVSH}	SI1, SCK1 SI2, SCK2		$1/2\ t_{inst}$*	—	µs	
SCK1 ↑ → valid SI1 hold time SCK2 ↑ → valid SI2 hold time	t_{SHIX}	SCK1, SI1 SCK2, SI2		$1/2\ t_{inst}$*	—	µs	
Serial clock "H" pulse width	t_{SHSL}	SCK1, SCK2	External shift clock mode	$1\ t_{inst}$*	—	µs	
Serial clock "L" pulse width	t_{SLSH}	SCK1, SCK2		$1\ t_{inst}$*	—	µs	
SCK1 ↓ → SO1 time SCK2 ↓ → SO2 time	t_{SLOV}	SCK1, SO1 SCK2, SO2		0	200	ns	
Valid SI1 → SCK1 ↑ Valid SI2 → SCK2 ↑	t_{IVSH}	SI1, SCK1 SI2, SCK2		$1/2\ t_{inst}$*	—	µs	
SCK1 ↑ → valid SI1 hold time SCK2 ↑ → valid SI2 hold time	t_{SHIX}	SCK1, SI1 SCK2, SI2		$1/2\ t_{inst}$*	—	µs	

*: For information on t_{inst}, see "(4) Instruction Cycle."

MB89620 Series

Internal Shift Clock Mode

External Shift Clock Mode

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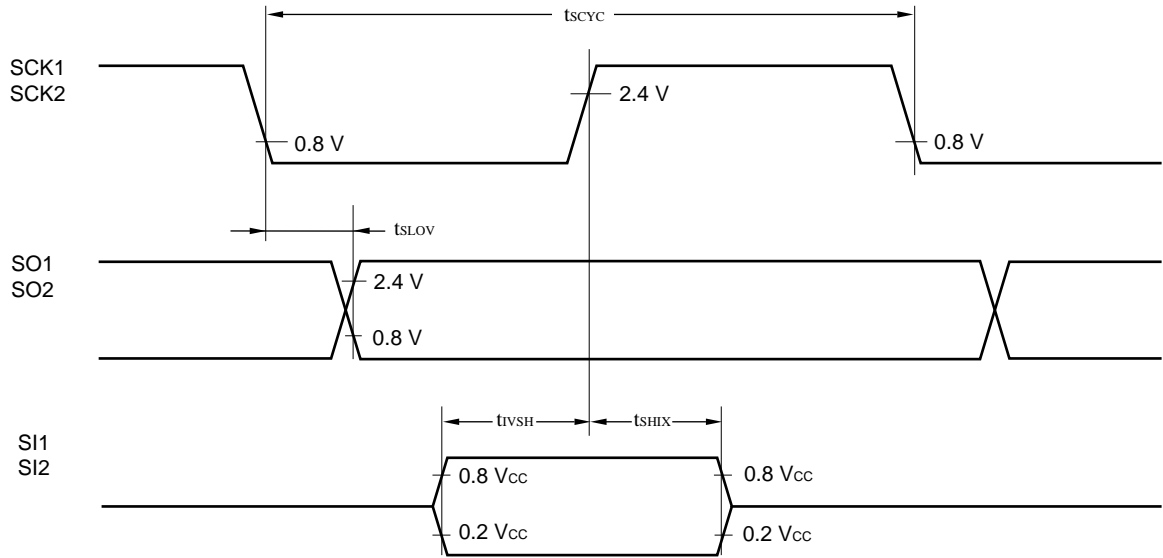
(11) Peripheral Input Timing

$(V_{CC} = +5.0 \text{ V} \pm 10\%, AV_{SS} = V_{SS} = 0.0 \text{ V}, T_A = -40°C \text{ to } +85°C)$

Parameter	Symbol	Pin	Condition	Value		Unit	Remarks
				Min.	Max.		
Peripheral input "H" pulse width 1	t_{ILIH1}	PWC, EC, INT0 to INT3	—	$2\ t_{inst}$*	—	µs	
Peripheral input "L" pulse width 1	t_{IHIL1}			$2\ t_{inst}$*	—	µs	
Peripheral input "H" pulse width 2	t_{ILIH2}	ADST	A/D mode	$32\ t_{inst}$*	—	µs	
Peripheral input "L" pulse width 2	t_{IHIL2}			$32\ t_{inst}$*	—	µs	
Peripheral input "H" pulse width 2	t_{ILIH2}		Sense mode	$8\ t_{inst}$*	—	µs	
Peripheral input "L" pulse width 2	t_{IHIL2}			$8\ t_{inst}$*	—	µs	

*: For information on t_{inst}, see "(4) Instruction Cycle."
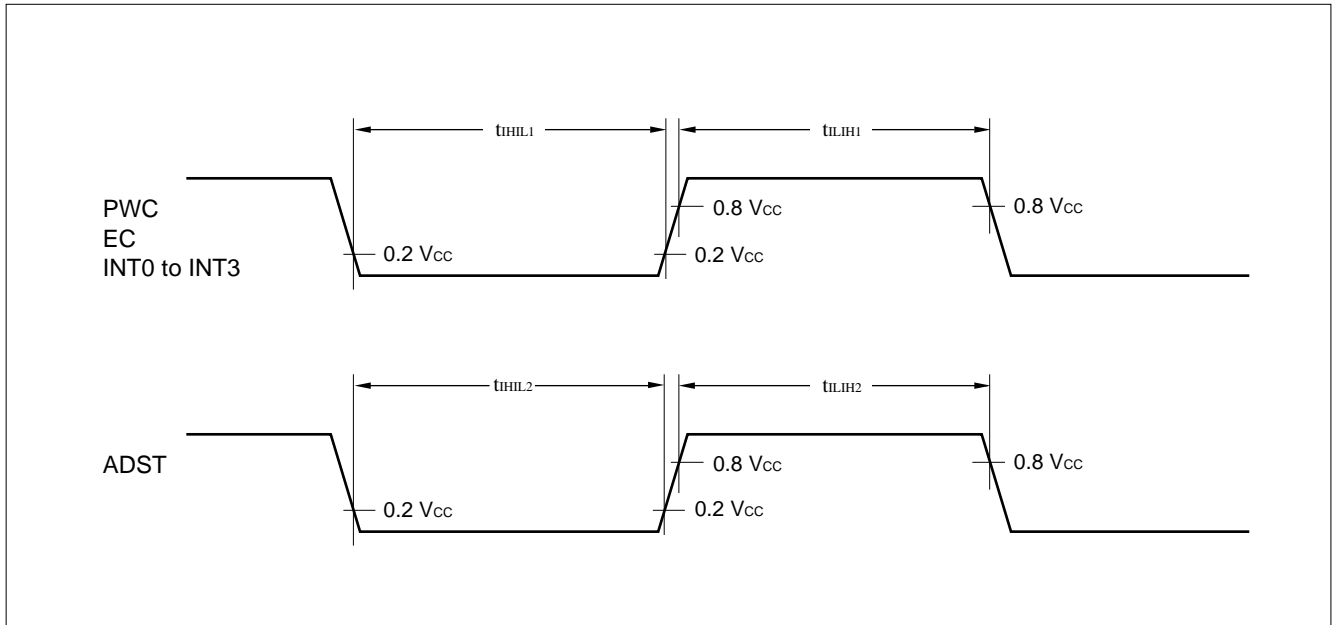
MB89620 Series

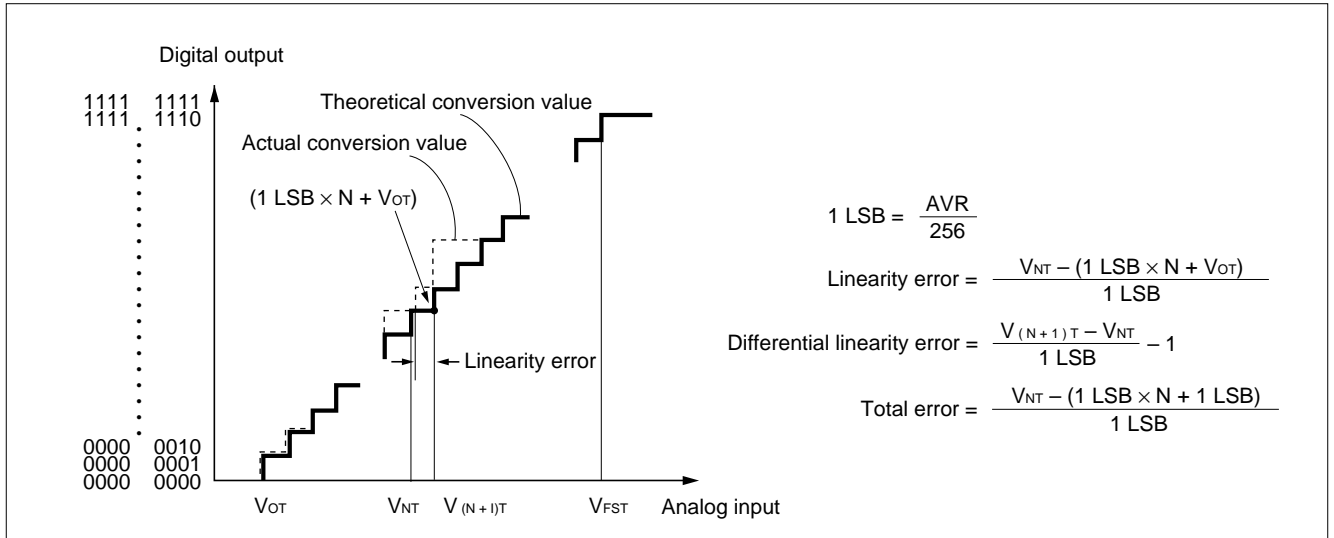## 5. A/D Converter Electrical Characteristics

(AVcc = Vcc = +3.5 V to +6.0 V, AVss = Vss = 0.0 V, TA = −40°C to +85°C)

Parameter	Symbol	Pin	Condition	Value			Unit	Remarks
				Min.	Typ.	Max.		
Resolution	—	—	—	—	—	8	bit	
Total error			AVR = AVcc	—	—	±1.5	LSB	
Linearity error				—	—	±1.0	LSB	
Differential linearity error				—	—	±0.9	LSB	
Zero transition voltage	VOT			AVss – 1.0 LSB	AVss + 0.5 LSB	AVss + 2.0 LSB	mV	
Full-scale transition voltage	VFST			AVR – 3.0 LSB	AVR – 1.5 LSB	AVR	mV	
Interchannel disparity				—	—	0.5	LSB	
A/D mode conversion time	—		—	—	44 t_{inst}*	—	μs	
Sense mode conversion time				—	12 t_{inst}*	—	μs	
Analog port input current	IAIN	AN0 to AN7		—	—	10	μA	
Analog input voltage	—			0.0	—	AVR	V	
Reference voltage	—			0.0	—	AVcc	V	
Reference voltage supply current	IR	AVR	AVR = 5.0 V, when A/D conversion is activated	—	100	—	μA	
	IRH		AVR = 5.0 V, when A/D conversion is stopped	—	—	1	μA	

*: For information on t_{inst}, see "(4) Instruction Cycle" in "4 AC Characteristics."

(1) A/D Glossary

- Resolution
  Analog changes that are identifiable with the A/D converter.
  When the number of bits is 8, analog voltage can be divided into $2^8 = 256$.

- Linearity error (unit: LSB)
  The deviation of the straight line connecting the zero transition point ("0000 0000" ↔ "0000 0001") with the full-scale transition point ("1111 1111" ↔ "1111 1110") from actual conversion characteristics

- Differential linearity error (unit: LSB)
  The deviation of input voltage needed to change the output code by 1 LSB from the theoretical value

- Total error (unit: LSB)
  The difference between theoretical and actual conversion values

$$1 \text{ LSB} = \frac{AVR}{256}$$

$$\text{Linearity error} = \frac{V_{NT} - (1 \text{ LSB} \times N + V_{OT})}{1 \text{ LSB}}$$

$$\text{Differential linearity error} = \frac{V_{(N+1)T} - V_{NT}}{1 \text{ LSB}} - 1$$

$$\text{Total error} = \frac{V_{NT} - (1 \text{ LSB} \times N + 1 \text{ LSB})}{1 \text{ LSB}}$$

(2) Precautions

• Input impedance of the analog input pins

The A/D converter contains a sample hold circuit as illustrated below to fetch analog input voltage into the sample hold capacitor for eight instruction cycles after activating A/D conversion.

For this reason, if the output impedance of the external circuit for the analog input is high, analog input voltage might not stabilize within the analog input sampling period. Therefore, it is recommended to keep the output impedance of the external circuit low (below 10 kΩ).

Note that if the impedance cannot be kept low, it is recommended to connect an external capacitor of about 0.1 μF for the analog input pin.

Analog Input Equivalent Circiut
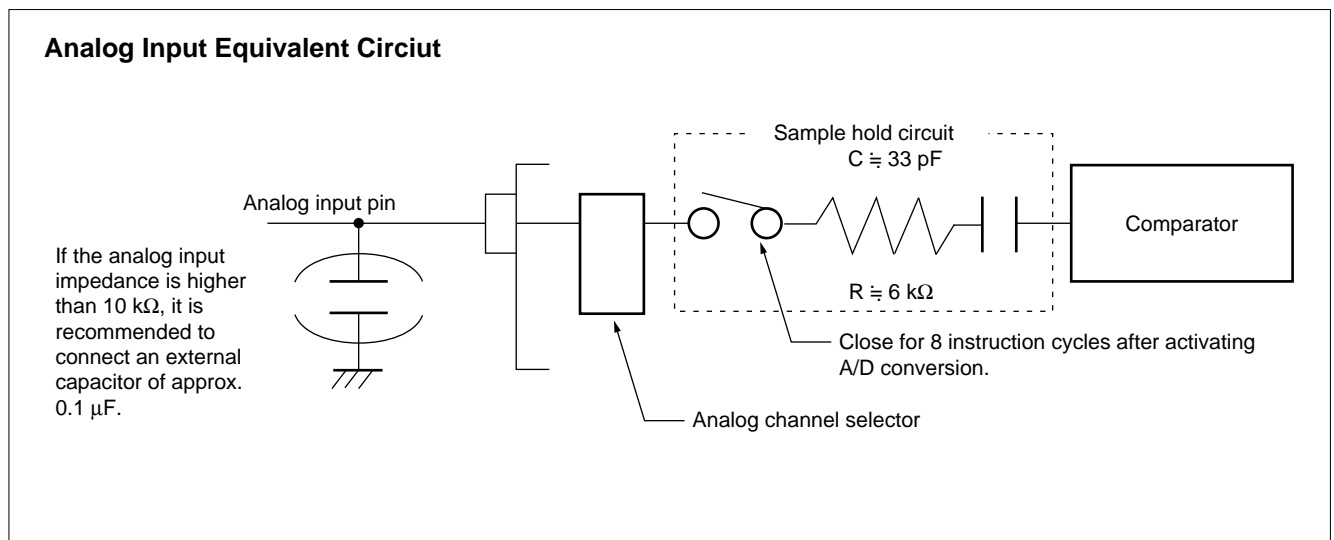
• Error

The smaller the $| AVR - AV_{SS} |$, the greater the error would become relatively.

MB89620 Series

■ EXAMPLE CHARACTERISTIC

(1) "L" Level Output Voltage

V_{OL} vs. I_{OL}

V_{OL} (V)

$T_A = +25°C$

$V_{CC} = 2.5$ V
$V_{CC} = 3.0$ V
$V_{CC} = 4.0$ V
$V_{CC} = 5.0$ V
$V_{CC} = 6.0$ V

0.5
0.4
0.3
0.2
0.1

0 1 2 3 4 5 6 7 8 9 10

I_{OL} (mA)

(2) "H" Level Output Voltage

$V_{CC} - V_{OH}$ vs. I_{OH}

$V_{CC} - V_{OH}$ (V)

$T_A = +25°C$

$V_{CC} = 2.5$ V
$V_{CC} = 3.0$ V
$V_{CC} = 4.0$ V
$V_{CC} = 5.0$ V
$V_{CC} = 6.0$ V

1.0
0.9
0.8
0.7
0.6
0.5
0.4
0.3
0.2
0.1
0.0

0.0 −0.5 −1.0 −1.5 −2.0 −2.5 −3.0

I_{OH} (mA)
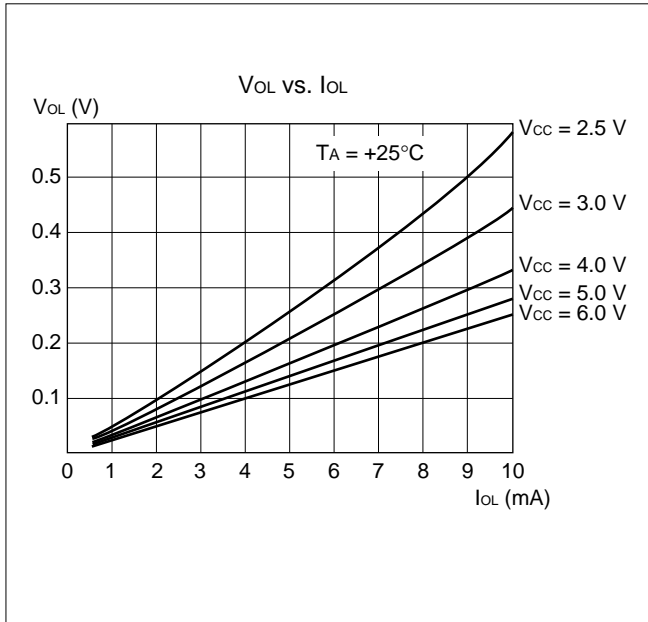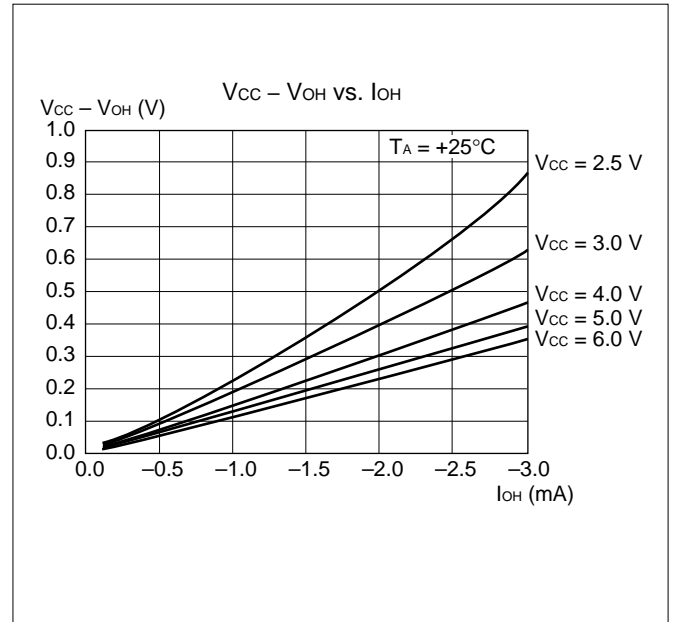
(3) "H" Level Input Voltage/"L" Level Input Voltage (CMOS Input)

V_{IN} vs. V_{CC}

V_{IN} (V)

$T_A = +25°C$

5.0
4.5
4.0
3.5
3.0
2.5
2.0
1.5
1.0
0.5
0.0

0 1 2 3 4 5 6 7

V_{CC} (V)
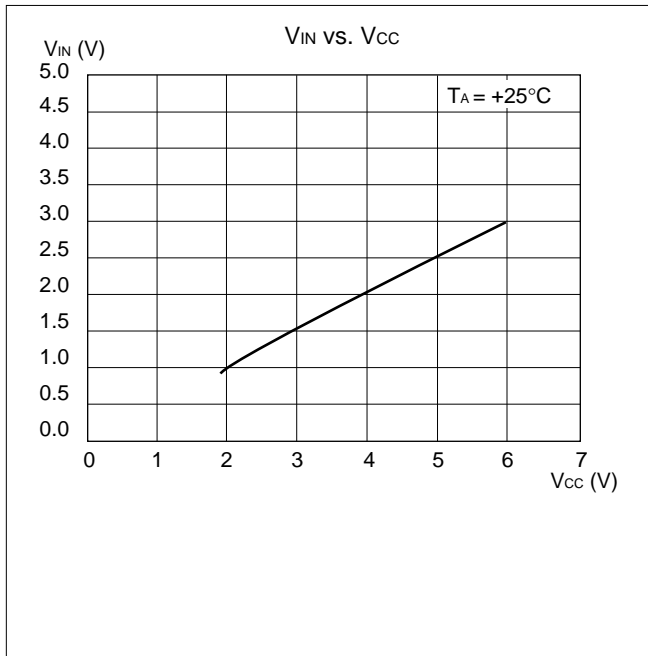
(4) "H" Level Input Voltage/"L" Level Input Voltage (Hysteresis Input)

V_{IN} vs. V_{CC}

V_{IN} (V)

$T_A = +25°C$

V_{IHS}
V_{ILS}

5.0
4.5
4.0
3.5
3.0
2.5
2.0
1.5
1.0
0.5
0.0

0 1 2 3 4 5 6 7

V_{CC} (V)

V_{IHS}: Threshold when input voltage in hysteresis characteristics is set to "H" level

V_{ILS}: Threshold when input voltage in hysteresis characteristics is set to "L" level

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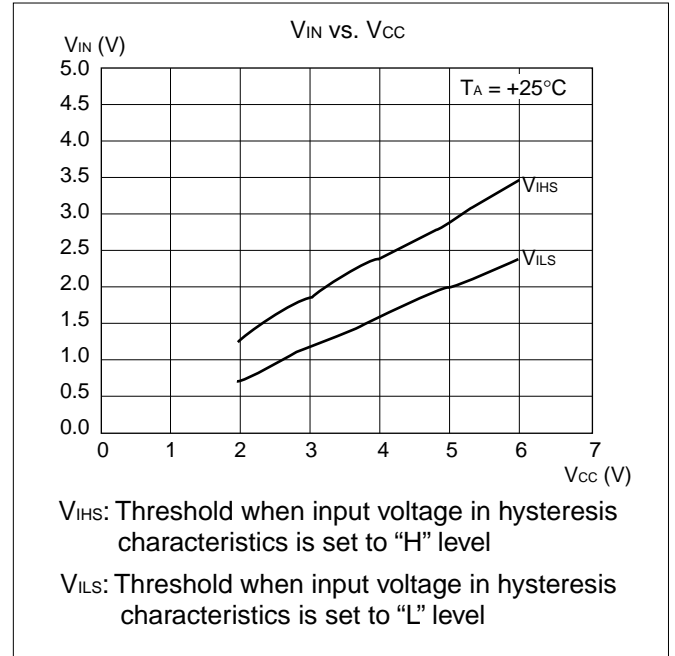
(5) Power Supply Current (External Clock)

ICC vs. VCC

ICC (mA)

TA = +25°C
FC = 10 MHz
FC = 8 MHz
FC = 4 MHz
FC = 1 MHz

VCC (V)

ICCS vs. VCC

ICCS (mA)

TA = +25°C
FC = 10 MHz
FC = 8 MHz
FC = 4 MHz
FC = 1 MHz

VCC (V)

IA vs. AVCC

IA (mA)

FC = 10 MHz
TA = +25°C

AVCC (V)

IR vs. AVR

IR (μA)

TA = +25°C

AVR (V)

(6) Pull-up Resistance

RPULL vs. VCC

RPULL (kΩ)

TA = +25°C

VCC (V)
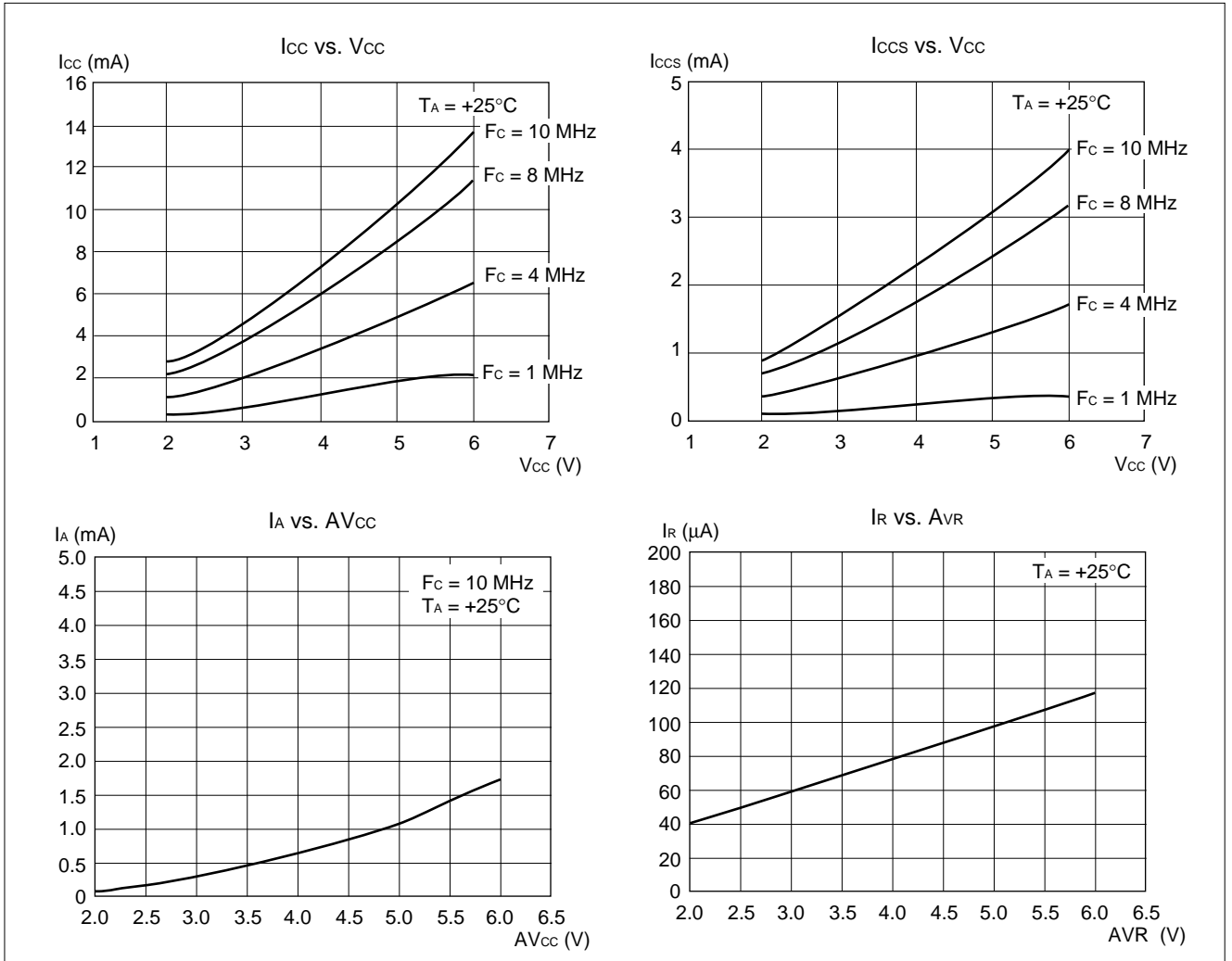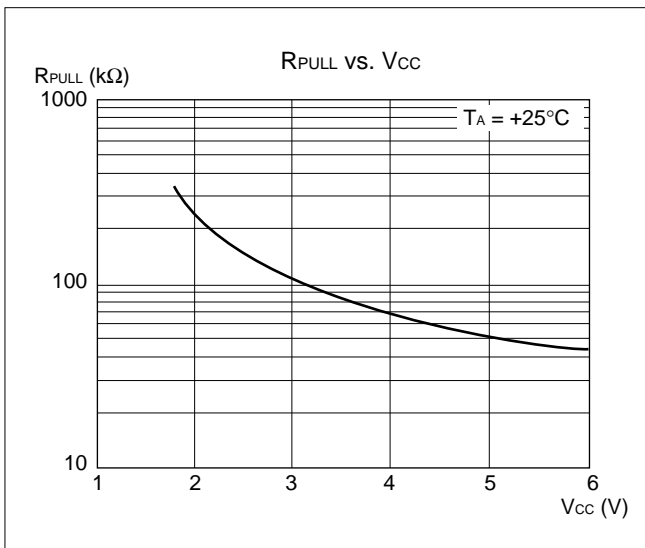
MB89620 Series

■ INSTRUCTIONS

Execution instructions can be divided into the following four groups:

• Transfer
• Arithmetic operation
• Branch
• Others

Table 1 lists symbols used for notation of instructions.

Table 1   Instruction Symbols

Symbol	Meaning
dir	Direct address (8 bits)
off	Offset (8 bits)
ext	Extended address (16 bits)
#vct	Vector table number (3 bits)
#d8	Immediate data (8 bits)
#d16	Immediate data (16 bits)
dir: b	Bit direct address (8:3 bits)
rel	Branch relative address (8 bits)
@	Register indirect (Example: @A, @IX, @EP)
A	Accumulator A (Whether its length is 8 or 16 bits is determined by the instruction in use.)
AH	Upper 8 bits of accumulator A (8 bits)
AL	Lower 8 bits of accumulator A (8 bits)
T	Temporary accumulator T (Whether its length is 8 or 16 bits is determined by the instruction in use.)
TH	Upper 8 bits of temporary accumulator T (8 bits)
TL	Lower 8 bits of temporary accumulator T (8 bits)
IX	Index register IX (16 bits)

(Continued)

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(Continued)

Symbol	Meaning
EP	Extra pointer EP (16 bits)
PC	Program counter PC (16 bits)
SP	Stack pointer SP (16 bits)
PS	Program status PS (16 bits)
dr	Accumulator A or index register IX (16 bits)
CCR	Condition code register CCR (8 bits)
RP	Register bank pointer RP (5 bits)
Ri	General-purpose register Ri (8 bits, i = 0 to 7)
$\times$	Indicates that the very $\times$ is the immediate data. (Whether its length is 8 or 16 bits is determined by the instruction in use.)
$(\times)$	Indicates that the contents of $\times$ is the target of accessing. (Whether its length is 8 or 16 bits is determined by the instruction in use.)
$((\times))$	The address indicated by the contents of $\times$ is the target of accessing. (Whether its length is 8 or 16 bits is determined by the instruction in use.)

Columns indicate the following:

Mnemonic: Assembler notation of an instruction

~: Number of instructions

#: Number of bytes

Operation: Operation of an instruction

TL, TH, AH: A content change when each of the TL, TH, and AH instructions is executed. Symbols in the column indicate the following:

- "–" indicates no change.
- dH is the 8 upper bits of operation description data.
- AL and AH must become the contents of AL and AH immediately before the instruction is executed.
- 00 becomes 00.

N, Z, V, C: An instruction of which the corresponding flag will change. If + is written in this column, the relevant instruction will change its corresponding flag.

OP code: Code of an instruction. If an instruction is more than one code, it is written according to the following rule:

Example: 48 to 4F ← This indicates 48, 49, ... 4F.

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Table 2 Transfer Instructions (48 instructions)

Mnemonic	~	#	Operation	TL	TH	AH	N Z V C	OP code
MOV dir,A	3	2	(dir) ← (A)	–	–	–	– – – –	45
MOV @IX +off,A	4	2	((IX) +off) ← (A)	–	–	–	– – – –	46
MOV ext,A	4	3	(ext) ← (A)	–	–	–	– – – –	61
MOV @EP,A	3	1	((EP)) ← (A)	–	–	–	– – – –	47
MOV Ri,A	3	1	(Ri) ← (A)	–	–	–	– – – –	48 to 4F
MOV A,#d8	2	2	(A) ← d8	AL	–	–	+ + – –	04
MOV A,dir	3	2	(A) ← (dir)	AL	–	–	+ + – –	05
MOV A,@IX +off	4	2	(A) ← ((IX) +off)	AL	–	–	+ + – –	06
MOV A,ext	4	3	(A) ← (ext)	AL	–	–	+ + – –	60
MOV A,@A	3	1	(A) ← ((A))	AL	–	–	+ + – –	92
MOV A,@EP	3	1	(A) ← ((EP))	AL	–	–	+ + – –	07
MOV A,Ri	3	1	(A) ← (Ri)	AL	–	–	+ + – –	08 to 0F
MOV dir,#d8	4	3	(dir) ← d8	–	–	–	– – – –	85
MOV @IX +off,#d8	5	3	((IX) +off) ← d8	–	–	–	– – – –	86
MOV @EP,#d8	4	2	((EP)) ← d8	–	–	–	– – – –	87
MOV Ri,#d8	4	2	(Ri) ← d8	–	–	–	– – – –	88 to 8F
MOVW dir,A	4	2	(dir) ← (AH),(dir + 1) ← (AL)	–	–	–	– – – –	D5
MOVW @IX +off,A	5	2	((IX) +off) ← (AH), ((IX) +off + 1) ← (AL)	–	–	–	– – – –	D6
MOVW ext,A	5	3	(ext) ← (AH), (ext + 1) ← (AL)	–	–	–	– – – –	D4
MOVW @EP,A	4	1	((EP)) ← (AH),((EP) + 1) ← (AL)	–	–	–	– – – –	D7
MOVW EP,A	2	1	(EP) ← (A)	–	–	–	– – – –	E3
MOVW A,#d16	3	3	(A) ← d16	AL	AH	dH	+ + – –	E4
MOVW A,dir	4	2	(AH) ← (dir), (AL) ← (dir + 1)	AL	AH	dH	+ + – –	C5
MOVW A,@IX +off	5	2	(AH) ← ((IX) +off), (AL) ← ((IX) +off + 1)	AL	AH	dH	+ + – –	C6
MOVW A,ext	5	3	(AH) ← (ext), (AL) ← (ext + 1)	AL	AH	dH	+ + – –	C4
MOVW A,@A	4	1	(AH) ← ((A)), (AL) ← ((A)) + 1)	AL	AH	dH	+ + – –	93
MOVW A,@EP	4	1	(AH) ← ((EP)), (AL) ← ((EP) + 1)	AL	AH	dH	+ + – –	C7
MOVW A,EP	2	1	(A) ← (EP)	–	–	dH	– – – –	F3
MOVW EP,#d16	3	3	(EP) ← d16	–	–	–	– – – –	E7
MOVW IX,A	2	1	(IX) ← (A)	–	–	–	– – – –	E2
MOVW A,IX	2	1	(A) ← (IX)	–	–	dH	– – – –	F2
MOVW SP,A	2	1	(SP) ← (A)	–	–	–	– – – –	E1
MOVW A,SP	2	1	(A) ← (SP)	–	–	dH	– – – –	F1
MOV @A,T	3	1	((A)) ← (T)	–	–	–	– – – –	82
MOVW @A,T	4	1	((A)) ← (TH),((A) + 1) ← (TL)	–	–	–	– – – –	83
MOVW IX,#d16	3	3	(IX) ← d16	–	–	–	– – – –	E6
MOVW A,PS	2	1	(A) ← (PS)	–	–	dH	– – – –	70
MOVW PS,A	2	1	(PS) ← (A)	–	–	–	+ + + +	71
MOVW SP,#d16	3	3	(SP) ← d16	–	–	–	– – – –	E5
SWAP	2	1	(AH) ↔ (AL)	–	–	AL	– – – –	10
SETB dir: b	4	2	(dir): b ← 1	–	–	–	– – – –	A8 to AF
CLRB dir: b	4	2	(dir): b ← 0	–	–	–	– – – –	A0 to A7
XCH A,T	2	1	(AL) ↔ (TL)	AL	–	–	– – – –	42
XCHW A,T	3	1	(A) ↔ (T)	AL	AH	dH	– – – –	43
XCHW A,EP	3	1	(A) ↔ (EP)	–	–	dH	– – – –	F7
XCHW A,IX	3	1	(A) ↔ (IX)	–	–	dH	– – – –	F6
XCHW A,SP	3	1	(A) ↔ (SP)	–	–	dH	– – – –	F5
MOVW A,PC	2	1	(A) ← (PC)	–	–	dH	– – – –	F0

Notes: • During byte transfer to A, T ← A is restricted to low bytes.
 • Operands in more than one operand instruction must be stored in the order in which their mnemonics are written. (Reverse arrangement of F²MC-8 family)

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Table 3 Arithmetic Operation Instructions (62 instructions)

Mnemonic	~	#	Operation	TL	TH	AH	N Z V C	OP code
ADDC A,Ri	3	1	(A) ← (A) + (Ri) + C	–	–	–	+ + + +	28 to 2F
ADDC A,#d8	2	2	(A) ← (A) + d8 + C	–	–	–	+ + + +	24
ADDC A,dir	3	2	(A) ← (A) + (dir) + C	–	–	–	+ + + +	25
ADDC A,@IX +off	4	2	(A) ← (A) + ((IX) +off) + C	–	–	–	+ + + +	26
ADDC A,@EP	3	1	(A) ← (A) + ((EP)) + C	–	–	–	+ + + +	27
ADDCW A	3	1	(A) ← (A) + (T) + C	–	–	dH	+ + + +	23
ADDC A	2	1	(AL) ← (AL) + (TL) + C	–	–	–	+ + + +	22
SUBC A,Ri	3	1	(A) ← (A) – (Ri) – C	–	–	–	+ + + +	38 to 3F
SUBC A,#d8	2	2	(A) ← (A) – d8 – C	–	–	–	+ + + +	34
SUBC A,dir	3	2	(A) ← (A) – (dir) – C	–	–	–	+ + + +	35
SUBC A,@IX +off	4	2	(A) ← (A) – ((IX) +off) – C	–	–	–	+ + + +	36
SUBC A,@EP	3	1	(A) ← (A) – ((EP)) – C	–	–	–	+ + + +	37
SUBCW A	3	1	(A) ← (T) – (A) – C	–	–	dH	+ + + +	33
SUBC A	2	1	(AL) ← (TL) – (AL) – C	–	–	–	+ + + +	32
INC Ri	4	1	(Ri) ← (Ri) + 1	–	–	–	+ + + –	C8 to CF
INCW EP	3	1	(EP) ← (EP) + 1	–	–	–	– – – –	C3
INCW IX	3	1	(IX) ← (IX) + 1	–	–	–	– – – –	C2
INCW A	3	1	(A) ← (A) + 1	–	–	dH	+ + – –	C0
DEC Ri	4	1	(Ri) ← (Ri) – 1	–	–	–	+ + + –	D8 to DF
DECW EP	3	1	(EP) ← (EP) – 1	–	–	–	– – – –	D3
DECW IX	3	1	(IX) ← (IX) – 1	–	–	–	– – – –	D2
DECW A	3	1	(A) ← (A) – 1	–	–	dH	+ + – –	D0
MULU A	19	1	(A) ← (AL) × (TL)	–	–	dH	– – – –	01
DIVU A	21	1	(A) ← (T) / (AL),MOD → (T)	dL	00	00	– – – –	11
ANDW A	3	1	(A) ← (A) ∧ (T)	–	–	dH	+ + R –	63
ORW A	3	1	(A) ← (A) ∨ (T)	–	–	dH	+ + R –	73
XORW A	3	1	(A) ← (A) ∀ (T)	–	–	dH	+ + R –	53
CMP A	2	1	(TL) – (AL)	–	–	–	+ + + +	12
CMPW A	3	1	(T) – (A)	–	–	–	+ + + +	13
RORC A	2	1	→ C → A ⌐	–	–	–	+ + – +	03
ROLC A	2	1	⌐ C ← A ←	–	–	–	+ + – +	02
CMP A,#d8	2	2	(A) – d8	–	–	–	+ + + +	14
CMP A,dir	3	2	(A) – (dir)	–	–	–	+ + + +	15
CMP A,@EP	3	1	(A) – ((EP))	–	–	–	+ + + +	17
CMP A,@IX +off	4	2	(A) – ((IX) +off)	–	–	–	+ + + +	16
CMP A,Ri	3	1	(A) – (Ri)	–	–	–	+ + + +	18 to 1F
DAA	2	1	Decimal adjust for addition	–	–	–	+ + + +	84
DAS	2	1	Decimal adjust for subtraction	–	–	–	+ + + +	94
XOR A	2	1	(A) ← (AL) ∀ (TL)	–	–	–	+ + R –	52
XOR A,#d8	2	2	(A) ← (AL) ∀ d8	–	–	–	+ + R –	54
XOR A,dir	3	2	(A) ← (AL) ∀ (dir)	–	–	–	+ + R –	55
XOR A,@EP	3	1	(A) ← (AL) ∀ ((EP))	–	–	–	+ + R –	57
XOR A,@IX +off	4	2	(A) ← (AL) ∀ ((IX) +off)	–	–	–	+ + R –	56
XOR A,Ri	3	1	(A) ← (AL) ∀ (Ri)	–	–	–	+ + R –	58 to 5F
AND A	2	1	(A) ← (AL) ∧ (TL)	–	–	–	+ + R –	62
AND A,#d8	2	2	(A) ← (AL) ∧ d8	–	–	–	+ + R –	64
AND A,dir	3	2	(A) ← (AL) ∧ (dir)	–	–	–	+ + R –	65

(Continued)

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(Continued)

Mnemonic	~	#	Operation	TL	TH	AH	N Z V C	OP code
AND A,@EP	3	1	(A) ← (AL) ∧ ((EP))	–	–	–	+ + R –	67
AND A,@IX +off	4	2	(A) ← (AL) ∧ ((IX) +off)	–	–	–	+ + R –	66
AND A,Ri	3	1	(A) ← (AL) ∧ (Ri)	–	–	–	+ + R –	68 to 6F
OR A	2	1	(A) ← (AL) ∨ (TL)	–	–	–	+ + R –	72
OR A,#d8	2	2	(A) ← (AL) ∨ d8	–	–	–	+ + R –	74
OR A,dir	3	2	(A) ← (AL) ∨ (dir)	–	–	–	+ + R –	75
OR A,@EP	3	1	(A) ← (AL) ∨ ((EP))	–	–	–	+ + R –	77
OR A,@IX +off	4	2	(A) ← (AL) ∨ ((IX) +off)	–	–	–	+ + R –	76
OR A,Ri	3	1	(A) ← (AL) ∨ (Ri)	–	–	–	+ + R –	78 to 7F
CMP dir,#d8	5	3	(dir) – d8	–	–	–	+ + + +	95
CMP @EP,#d8	4	2	((EP)) – d8	–	–	–	+ + + +	97
CMP @IX +off,#d8	5	3	((IX) + off) – d8	–	–	–	+ + + +	96
CMP Ri,#d8	4	2	(Ri) – d8	–	–	–	+ + + +	98 to 9F
INCW SP	3	1	(SP) ← (SP) + 1	–	–	–	– – – –	C1
DECW SP	3	1	(SP) ← (SP) – 1	–	–	–	– – – –	D1

Table 4   Branch Instructions (17 instructions)

Mnemonic	~	#	Operation	TL	TH	AH	N Z V C	OP code
BZ/BEQ rel	3	2	If Z = 1 then PC ← PC + rel	–	–	–	– – – –	FD
BNZ/BNE rel	3	2	If Z = 0 then PC ← PC + rel	–	–	–	– – – –	FC
BC/BLO rel	3	2	If C = 1 then PC ← PC + rel	–	–	–	– – – –	F9
BNC/BHS rel	3	2	If C = 0 then PC ← PC + rel	–	–	–	– – – –	F8
BN rel	3	2	If N = 1 then PC ← PC + rel	–	–	–	– – – –	FB
BP rel	3	2	If N = 0 then PC ← PC + rel	–	–	–	– – – –	FA
BLT rel	3	2	If V ∀ N = 1 then PC ← PC + rel	–	–	–	– – – –	FF
BGE rel	3	2	If V ∀ N = 0 then PC ← PC + rel	–	–	–	– – – –	FE
BBC dir: b,rel	5	3	If (dir: b) = 0 then PC ← PC + rel	–	–	–	– + – –	B0 to B7
BBS dir: b,rel	5	3	If (dir: b) = 1 then PC ← PC + rel	–	–	–	– + – –	B8 to BF
JMP @A	2	1	(PC) ← (A)	–	–	–	– – – –	E0
JMP ext	3	3	(PC) ← ext	–	–	–	– – – –	21
CALLV #vct	6	1	Vector call	–	–	–	– – – –	E8 to EF
CALL ext	6	3	Subroutine call	–	–	–	– – – –	31
XCHW A,PC	3	1	(PC) ← (A),(A) ← (PC) + 1	–	–	dH	– – – –	F4
RET	4	1	Return from subrountine	–	–	–	– – – –	20
RETI	6	1	Return form interrupt	–	–	–	Restore	30

Table 5   Other Instructions (9 instructions)

Mnemonic	~	#	Operation	TL	TH	AH	N Z V C	OP code
PUSHW A	4	1		–	–	–	– – – –	40
POPW A	4	1		–	–	dH	– – – –	50
PUSHW IX	4	1		–	–	–	– – – –	41
POPW IX	4	1		–	–	–	– – – –	51
NOP	1	1		–	–	–	– – – –	00
CLRC	1	1		–	–	–	– – – R	81
SETC	1	1		–	–	–	– – – S	91
CLRI	1	1		–	–	–	– – – –	80
SETI	1	1		–	–	–	– – – –	90

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■ INSTRUCTION MAP

L\H	0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F
0	NOP	SWAP	RET	RETI	PUSHW A	POPW A	MOV A,ext	MOVW A,PS	CLRI	SETI	CLRB dir:0	BBC dir:0,rel	INCW A	DECW A	JMP @A	MOVW A,PC
1	MULU A	DIVU A	JMP addr16	CALL addr16	PUSHW IX	POPW IX	MOV ext,A	MOVW PS,A	CLRC	SETC	CLRB dir:1	BBC dir:1,rel	INCW SP	DECW SP	MOVW SP,A	MOVW A,SP
2	ROLC A	CMP A	ADDC A	SUBC A	XCH A,T	XOR A	AND A	OR A	MOV @A,T	MOV A,@A	CLRB dir:2	BBC dir:2,rel	INCW IX	DECW IX	MOVW IX,A	MOVW A,IX
3	RORC A	CMPW A	ADDCW A	SUBCW A	XCHW A,T	XORW A	ANDW A	ORW A	MOVW @A,T	MOVW A,@A	CLRB dir:3	BBC dir:3,rel	INCW EP	DECW EP	MOVW EP,A	MOVW A,EP
4	MOV A,#d8	CMP A,#d8	ADDC A,#d8	SUBC A,#d8		XOR A,#d8	AND A,#d8	OR A,#d8	DAA	DAS	CLRB dir:4	BBC dir:4,rel	MOVW A,ext	MOVW ext,A	MOVW A,#d16	XCHW A,PC
5	MOV A,dir	CMP A,dir	ADDC A,dir	SUBC A,dir	MOV dir,A	XOR A,dir	AND A,dir	OR A,dir	MOV dir,#d8	CMP dir,#d8	CLRB dir:5	BBC dir:5,rel	MOVW A,dir	MOVW dir,A	MOVW SP,#d16	XCHW A,SP
6	MOV A,@IX+d	CMP A,@IX+d	ADDC A,@IX+d	SUBC A,@IX+d	MOV @IX+d,A	XOR A,@IX+d	AND A,@IX+d	OR A,@IX+d	MOV @IX+d,#d8	CMP @IX+d,#d8	CLRB dir:6	BBC dir:6,rel	MOVW A,@IX+d	MOVW @IX+d,A	MOVW IX,#d16	XCHW A,IX
7	MOV A,@EP	CMP A,@EP	ADDC A,@EP	SUBC A,@EP	MOV @EP,A	XOR A,@EP	AND A,@EP	OR A,@EP	MOV @EP,#d8	CMP @EP,#d8	CLRB dir:7	BBC dir:7,rel	MOVW A,@EP	MOVW @EP,A	MOVW EP,#d16	XCHW A,EP
8	MOV A,R0	CMP A,R0	ADDC A,R0	SUBC A,R0	MOV R0,A	XOR A,R0	AND A,R0	OR A,R0	MOV R0,#d8	CMP R0,#d8	SETB dir:0	BBS dir:0,rel	INC R0	DEC R0	CALLV #0	BNC rel
9	MOV A,R1	CMP A,R1	ADDC A,R1	SUBC A,R1	MOV R1,A	XOR A,R1	AND A,R1	OR A,R1	MOV R1,#d8	CMP R1,#d8	SETB dir:1	BBS dir:1,rel	INC R1	DEC R1	CALLV #1	BC rel
A	MOV A,R2	CMP A,R2	ADDC A,R2	SUBC A,R2	MOV R2,A	XOR A,R2	AND A,R2	OR A,R2	MOV R2,#d8	CMP R2,#d8	SETB dir:2	BBS dir:2,rel	INC R2	DEC R2	CALLV #2	BP rel
B	MOV A,R3	CMP A,R3	ADDC A,R3	SUBC A,R3	MOV R3,A	XOR A,R3	AND A,R3	OR A,R3	MOV R3,#d8	CMP R3,#d8	SETB dir:3	BBS dir:3,rel	INC R3	DEC R3	CALLV #3	BN rel
C	MOV A,R4	CMP A,R4	ADDC A,R4	SUBC A,R4	MOV R4,A	XOR A,R4	AND A,R4	OR A,R4	MOV R4,#d8	CMP R4,#d8	SETB dir:4	BBS dir:4,rel	INC R4	DEC R4	CALLV #4	BNZ rel
D	MOV A,R5	CMP A,R5	ADDC A,R5	SUBC A,R5	MOV R5,A	XOR A,R5	AND A,R5	OR A,R5	MOV R5,#d8	CMP R5,#d8	SETB dir:5	BBS dir:5,rel	INC R5	DEC R5	CALLV #5	BZ rel
E	MOV A,R6	CMP A,R6	ADDC A,R6	SUBC A,R6	MOV R6,A	XOR A,R6	AND A,R6	OR A,R6	MOV R6,#d8	CMP R6,#d8	SETB dir:6	BBS dir:6,rel	INC R6	DEC R6	CALLV #6	BGE rel
F	MOV A,R7	CMP A,R7	ADDC A,R7	SUBC A,R7	MOV R7,A	XOR A,R7	AND A,R7	OR A,R7	MOV R7,#d8	CMP R7,#d8	SETB dir:7	BBS dir:7,rel	INC R7	DEC R7	CALLV #7	BLT rel

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■ MASK OPTIONS

No.	Part number	MB89623 MB89625 MB89626 MB89627	MB89P625 MB89W625 MB89P627 MB89W627	MB89PV620 MB89V623 MB89T623 MB89T625
	Specifying procedure	**Specify when ordering masking**	**Set with EPROM programmer**	**Setting not possible**
1	Pull-up resistors ⌠ P00 to P07, P10 to P17, P30 to P37, P40 to P47, ⌡ P50 to P57, P60 to P64	Selectable per pin. (P50 to P57 must be set to without a pull-up resistor when an A/D converter is used.)	Can be set per pin. (P40 to P47 are available only for without a pull-up resistor.)	Fixed to without pull-up resistor
2	Power-on reset selection ⌠ With power-on reset ⌡ Without power-on reset	Selectable	Setting possible	Fixed to with power-on reset
3	Oscillation stabilization time selection ⌠ Crystal oscillator: $2^{18}/F_C(s)$) ⌡ Ceramic oscillator: $2^{14}/F_C(s)$)	Selectable	Setting possible	Crystal oscillator ($2^{18}/F_C(s)$)
4	Reset pin output ⌠ With reset output ⌡ Without reset output	Selectable	Setting possible	With reset output

Note: Reset is input asynchronized with the internal clock whether with or without power-on reset.
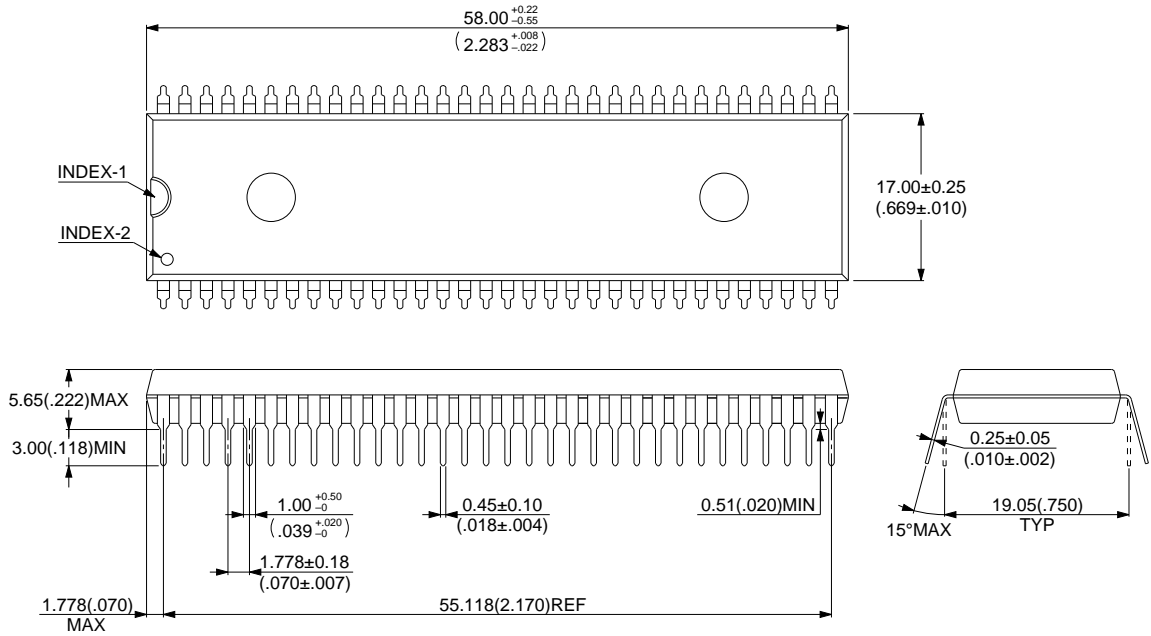
■ ORDERING INFORMATION

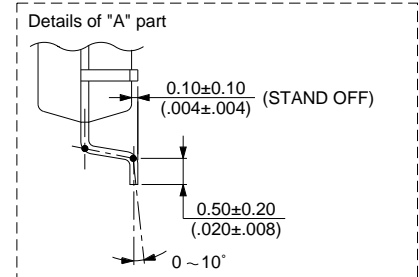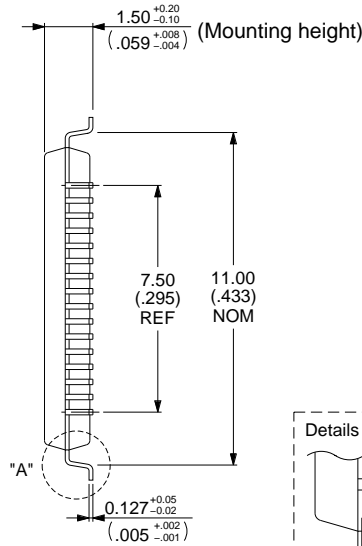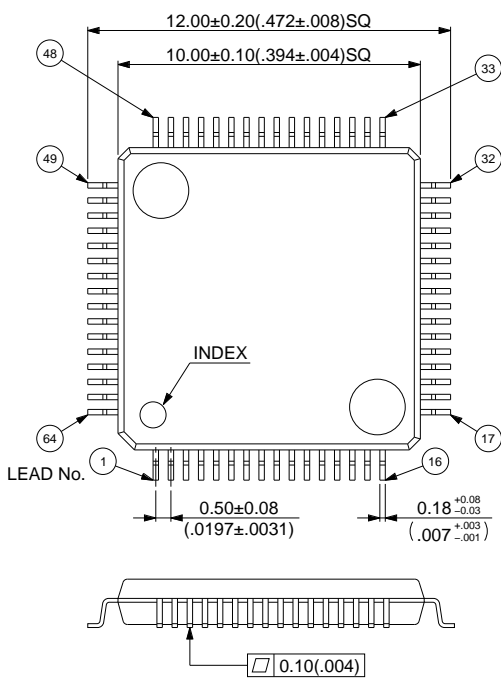| Part number	Package	Remarks
MB89623P-SH MB89625P-SH MB89626P-SH MB89627P-SH MB89P625P-SH MB89P627-SH MB89T623P-SH MB89T625P-SH MB89V623P-SH MB89V625P-SH	64-pin Plastic SH-DIP (DIP-64P-M01)	
MB89623PFV MB89625PFV MB89T623PFV MB89T625PFV	64-pin Plastic SQFP (FPT-64P-M03)	Lead pitch: 0.5 mm
MB89623PF MB89625PF MB89626PF MB89627PF MB89P625PF MB89P627PF MB89T623PF MB89T625PF	64-pin Plastic QFP (FPT-64P-M06)	Lead pitch: 1.0 mm
MB89623PFM MB89625PFM MB89626PFM MB89627PFM MB89P625PFM MB89T623PFM MB89T625PFM	64-pin Plastic QFP (FPT-64P-M09)	Lead pitch: 0.65 mm
MB89W625C-SH MB89W627C-SH	64-pin Ceramic SH-DIP (DIP-64C-A06)	
MB89PV620C-SH	64-pin Ceramic MDIP (MDP-64C-P02)	
MB89PV620CF	64-pin Ceramic MQFP (MQP-64C-P01)	

MB89620 Series

■ PACKAGE DIMENSIONS

64-pin Plastic SH-DIP
    (DIP-64P-M01)

INDEX-1

INDEX-2

$58.00^{+0.22}_{-0.55}$
$(2.283^{+.008}_{-.022})$

17.00 ± 0.25
$(.669\pm.010)$

5.65(.222)MAX

3.00(.118)MIN

$1.00^{+0.50}_{-0}$
$(.039^{+.020}_{-0})$

0.45 ± 0.10
$(.018\pm.004)$

0.51(.020)MIN

1.778 ± 0.18
$(.070\pm.007)$

1.778(.070)
MAX

55.118(2.170)REF

0.25 ± 0.05
$(.010\pm.002)$
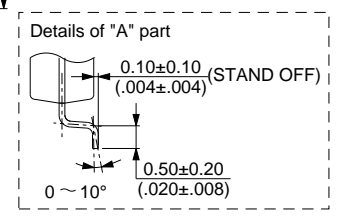
19.05(.750)
TYP

15°MAX

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Dimensions in mm (inches)

54

64-pin Plastic SQFP
(FPT-64P-M03)

12.00±0.20(.472±.008)SQ

10.00±0.10(.394±.004)SQ

48

33

49

32

INDEX

64

17

LEAD No. 1

16

0.50±0.08
(.0197±.0031)

$0.18^{+0.08}_{-0.03}$
$\left(.007^{+.003}_{-.001}\right)$

$1.50^{+0.20}_{-0.10}$
$\left(.059^{+.008}_{-.004}\right)$ (Mounting height)

7.50
(.295)
REF

11.00
(.433)
NOM

"A"

$0.127^{+0.05}_{-0.02}$
$\left(.005^{+.002}_{-.001}\right)$

Details of "A" part

0.10±0.10
(.004±.004) (STAND OFF)

0.50±0.20
(.020±.008)

0 ~ 10°

□ 0.10(.004)

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Dimensions in mm (inches)

MB89620 Series

64-pin Plastic QFP
(FPT-64P-M06)

24.70±0.40(.972±.016)

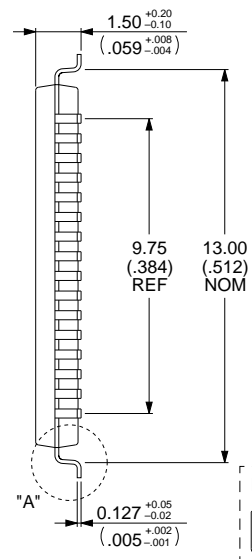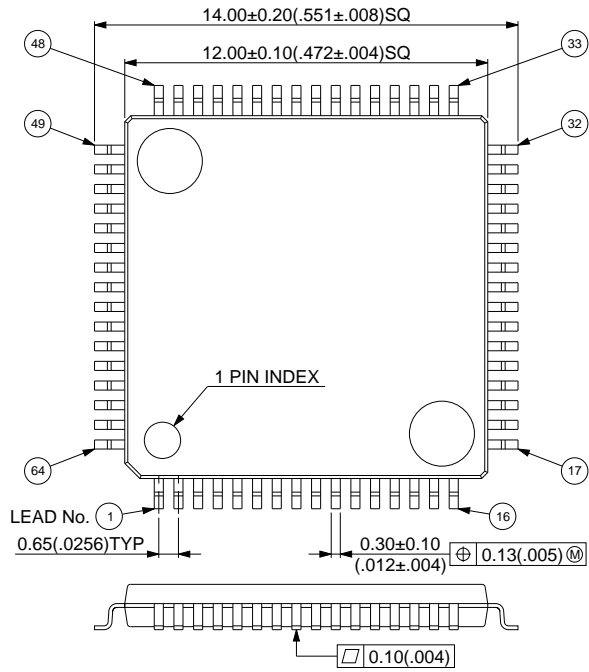20.00±0.20(.787±.008)

51
33
52
32
64

INDEX

"A"

14.00±0.20
(.551±.008)

18.70±0.40
(.736±.016)

LEAD No. 1

20

19

1.00(.0394)
TYP

0.40±0.10
(.016±.004)

⊕ 0.20(.008) Ⓜ

3.35(.132)MAX

0.05(.002)MIN
(STAND OFF)

12.00(.472)
REF

16.30±0.40
(.642±.016)

0.15±0.05(.006±.002)

"B"

▱ 0.10(.004)

18.00(.709)REF

22.30±0.40(.878±.016)

Details of "A" part

0.25(.010)

0.30(.012)

0.18(.007)MAX

0.63(.025)MAX

Details of "B" part

0 ~ 10°

1.20±0.20
(.047±.008)
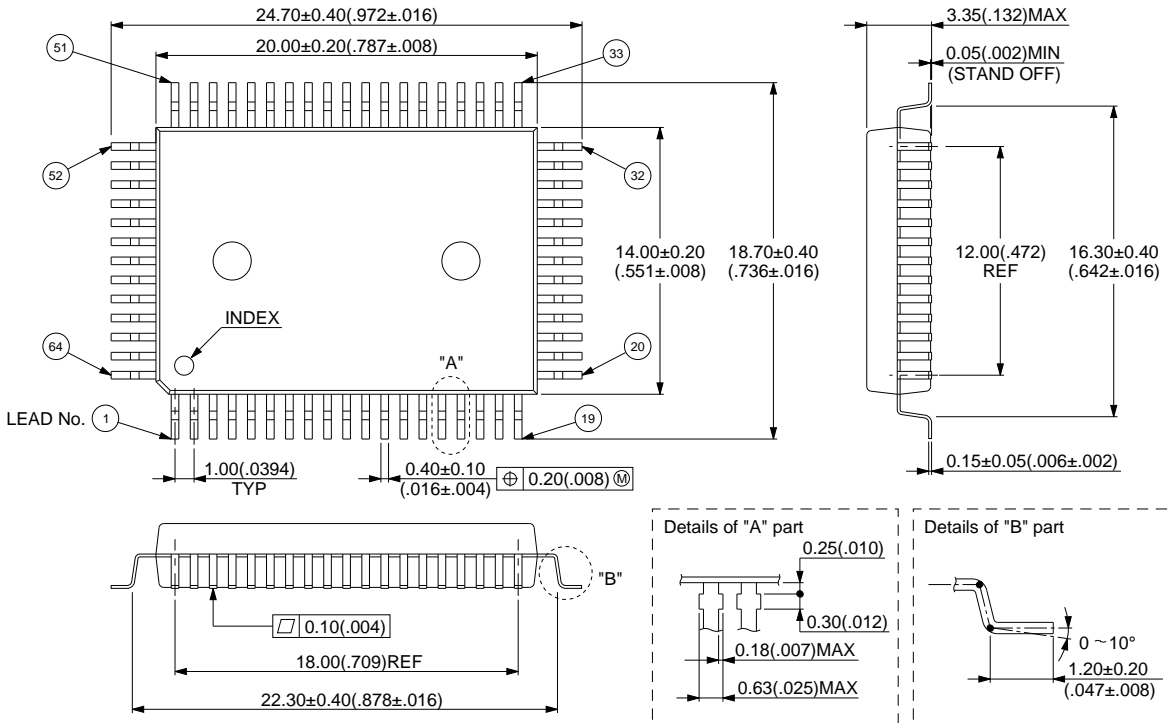
© 1994 FUJITSU LIMITED F64013S-3C-2

Dimensions in mm (inches)

64-pin Plastic QFP
(FPT-64P-M09)

14.00±0.20(.551±.008)SQ

12.00±0.10(.472±.004)SQ

1 PIN INDEX

LEAD No.

0.65(.0256)TYP

0.30±0.10
(.012±.004)

⊕ 0.13(.005) Ⓜ

▱ 0.10(.004)

1.50 $^{+0.20}_{-0.10}$
(.059 $^{+.008}_{-.004}$)

9.75
(.384)
REF

13.00
(.512)
NOM

"A"

0.127 $^{+0.05}_{-0.02}$
(.005 $^{+.002}_{-.001}$)

Details of "A" part

0.10±0.10 (STAND OFF)
(.004±.004)

0.50±0.20
(.020±.008)

0 ~ 10°

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Dimensions in mm (inches)

MB89620 Series

64-pin Ceramic SH-DIP
(DIP-64C-A06)

56.90±0.56
(2.240±.022)

8.89(.350) DIA
TYP

R1.27(.050)
REF

18.75±0.25
(.738±.010)

INDEX AREA

1.27±0.25
(.050±.010)

5.84(.230)MAX

0.25±0.05
(.010±.004)

3.40±0.36
(.134±.014)

1.778±0.180
(.070±.007)

0.90±0.10
(.0355±.0040)

$0.46^{+0.13}_{-0.08}$
$\left(.018^{+.005}_{-.003}\right)$

19.05±0.25
(.750±.010)

0°~9°

1.45(.057)
MAX

55.118(2.170)REF
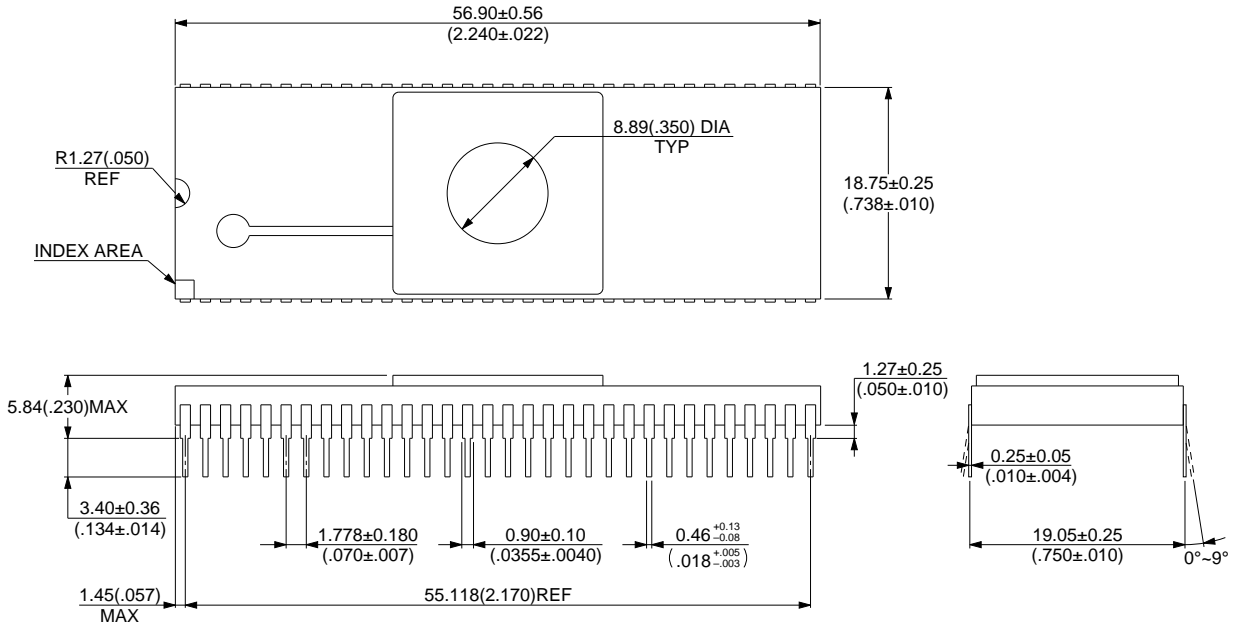
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Dimensions in mm (inches)

64-pin Ceramic MDIP
(MDP-64C-P02)

56.90±0.64
(2.240±.025)

0°~9°

15.24(.600)
TYP

18.75±0.30
(.738±.012)

19.05±0.30
(.750±.012)

INDEX AREA

2.54±0.25
(.100±.010)

33.02(1.300)REF

0.25±0.05
(.010±.002)

10.16(.400)MAX

1.27±0.25
(.050±.010)

1.778±0.25
(.070±.010)

$0.46 ^{+0.13}_{-0.08}$
$\left(.018 ^{+.005}_{-.003}\right)$

0.90±0.13
(.035±.005)

3.43±0.38
(.135±.015)

55.12(2.170)REF
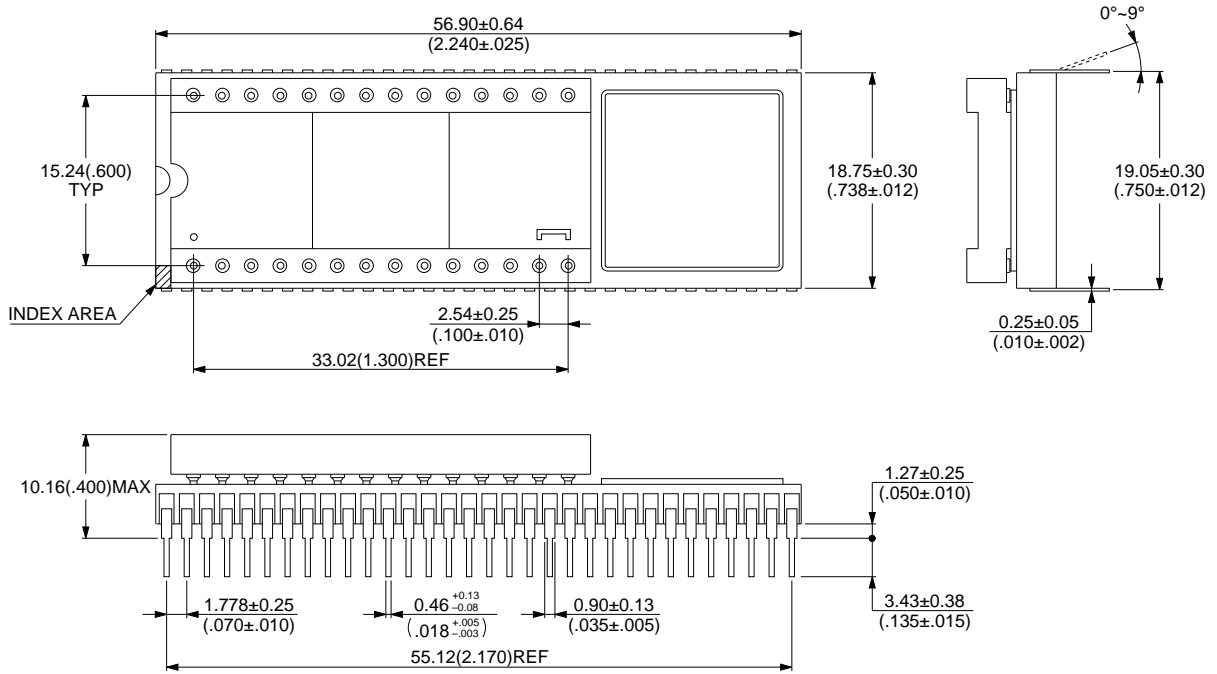
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Dimensions in mm (inches)

MB89620 Series

64-pin Ceramic MQFP
(MQP-64C-P01)

18.70(.736)TYP

16.30±0.33
(.642±.013)
15.58±0.20
(.613±.008)

INDEX AREA

1.27±0.13
(.050±.005)

22.30±0.33
(.878±.013)

24.70(.972)
TYP

0.30(.012)
TYP

12.02(.473)
TYP

10.16(.400)
TYP

14.22(.560)
TYP

18.12±0.20
(.713±.008)

1.27±0.13
(.050±.005)

0.30(.012)TYP

7.62(.300)TYP

9.48(.373)TYP

11.68(.460)TYP

12.00(.472)TYP

1.00±0.25
(.039±.010)

$1.20^{+0.40}_{-0.20}$
$\left(.047^{+.016}_{-.008}\right)$

1.00±0.25
(.039±.010)

18.00(.709)
TYP

0.40±0.10
(.016±.004)

0.40±0.10
(.016±.004)

$1.20^{+0.40}_{-0.20}$
$\left(.047^{+.016}_{-.008}\right)$

0.50(.020)TYP

10.82(.426)
MAX

0.15±0.05
(.006±.002)
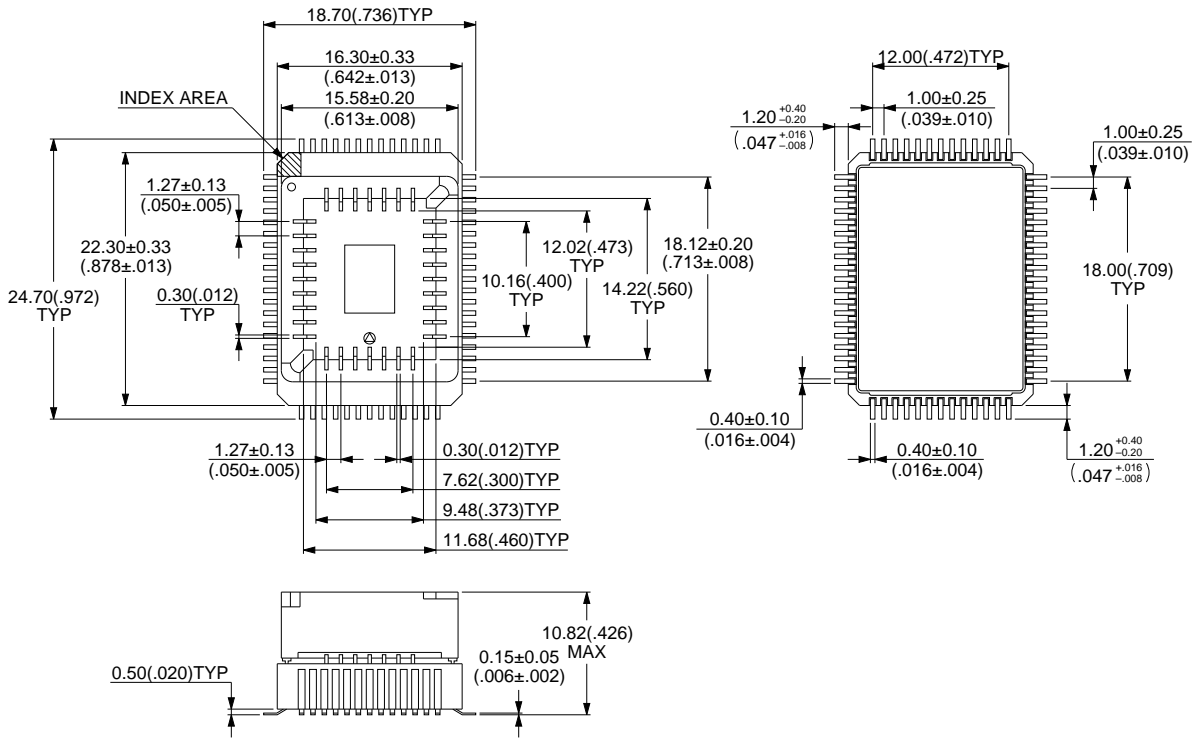
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Dimensions in mm (inches)

FUJITSU LIMITED

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